

# Next Generation Curve Tracing & Measurement Tips for Power Device

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# Agenda

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- Conventional Analog Curve Tracer & Measurement Challenges
- Next Generation Curve Tracing & Measurement Tips for Power Device
  - Next Generation Measurement Requirements
  - Tips for Precision IV Characterizations
  - Tips for CV, Qg & Current Collapse Measurement
  - Measurement Impact from Temperature and Small Pulse Width.
  - Compliance Setting & Waveform Inspection
- Keysight Solutions on High Power Curve Tracing

# What is a Conventional Analog Curve Tracer?

The conventional analog curve tracer has two main signal sources:

- A **collector supply** to sweep bias on the collector and
- A **step generator** to sweep the bias on the base terminal.

In a traditional curve tracer, a cathode ray tube (CRT) is used to display the IV curve. The voltage applied to the collector terminal is used to detect an electron beam horizontally and voltage across a shunt resistor (to measure collector current) is used to detect it vertically.

Normally curve tracer is use to perform **I-V curve measurement** for various semiconductor device like IGBTs, MOSFETs, Transistors, Diodes, etc.

Measurement example like:

- Resistor curve
- Diode curve (forward or reverse bias)
- Transistor curve ( $I_c$ - $V_{ce}$ )
- MOSFET / FET curve ( $I_d$ - $V_{ds}$ , Breakdown, saturation area)

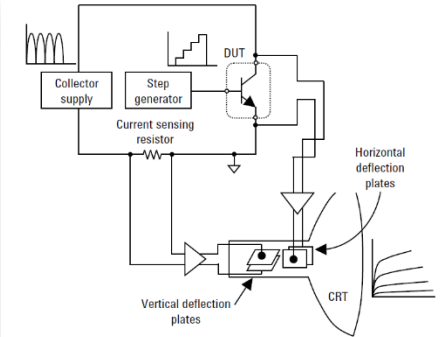
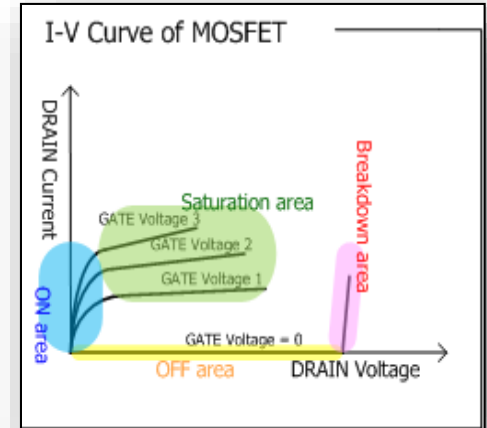
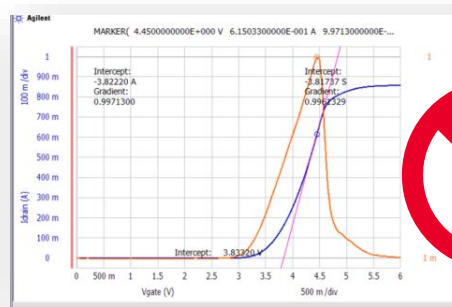


Figure 1. Simplified curve tracer circuit diagram.

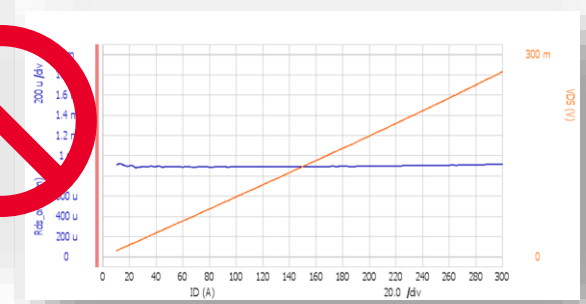


# Measurement Challenges using Conventional Analog Curve Tracer

1. Unable to measure **transfer characteristic** (Like  $I_d$ - $V_g$ ,  $g_m$ ,  $V_{th}$  and  $O_n$  resistance) accurately.
2. Difficult to **manage measurement data** (like curve comparison).
3. No **compliance feature** to avoid damaging the device.
4. Unable to measure **CV or  $Q_g$**  for advance power device.

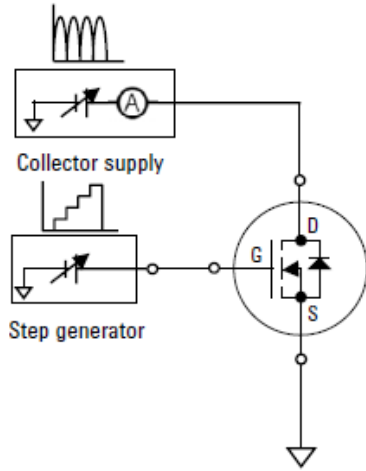


$I_d$ - $V_g$



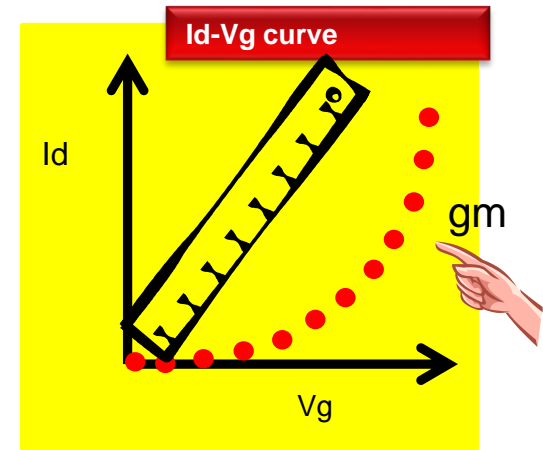
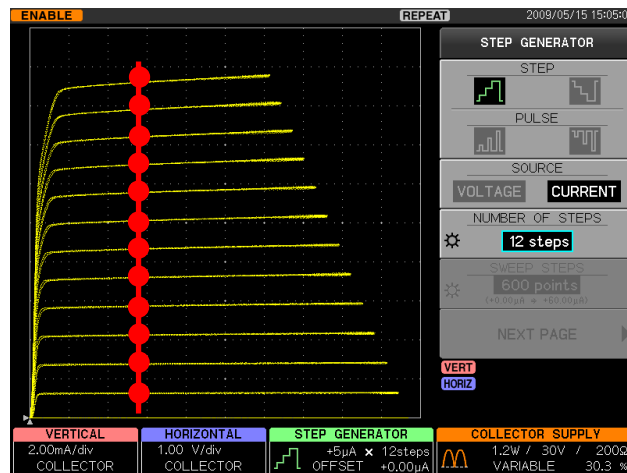
On-resistance

# It is not easy to extracting $I_d$ - $V_g$ , $g_m$ and $V_{th}$ Using a Traditional Curve Tracer



## Issues:

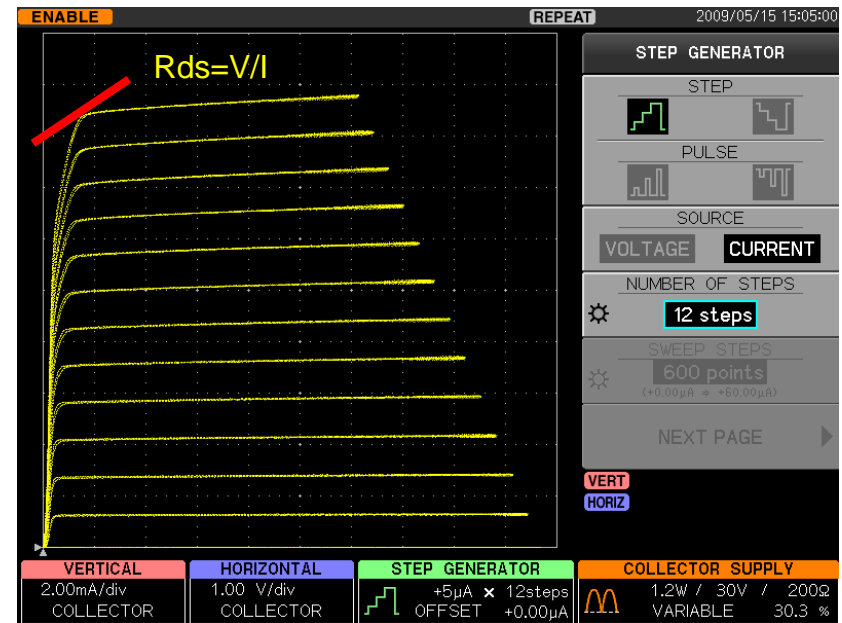
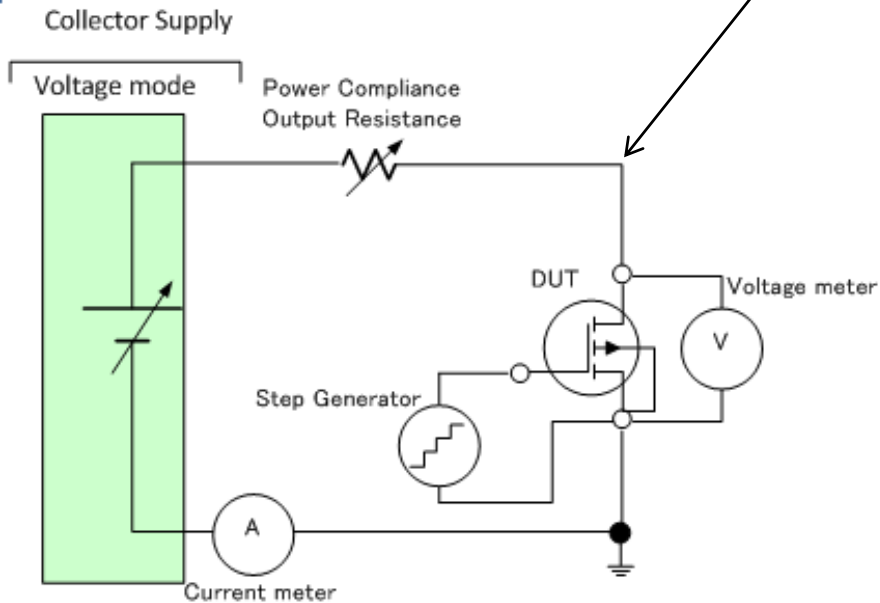
1. Curve tracer has ~ 20 steps maximum; insufficient for accurate  $g_m$  &  $V_{th}$  measurement
2. Extremely tedious to make this measurement; no easy way to automate it



# It is not easy to measuring On Resistance Using a Traditional Curve Tracer

## Curve Tracer Measurement:

Actual drain voltage varies with current.



→ The on resistance obtained from the  $I_d$ - $V_d$  curve gradient is not accurate, because the applied voltage at the drain is not constant.



# Next Generation Curve Tracing & Measurement Tips for Power Device

# Next Generation of Curve Tracing



## Able to Measure Complete Static Characteristic

- New curve tracer should be able to measure **complete static characteristic** like  $I_g$ - $V_g$ ,  $V_{th}$ ,  $I_{gss}$ ... and also **Transfer characteristic** like  $V_{ge}$ - $I_c$  /  $V_{ge}$ - $V_{ce}$ .



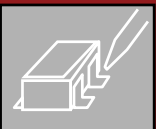
## Meet future power device measurement requirements

- WBG material (GaN / SiC) will improve the **switching frequency** in order to achieve higher energy efficiency.
- With higher switching frequency, **CV** and **Qg** characteristic become important parameters that need to be evaluated.



## Support automotive / mission critical requirements

- Mission critical operation like the automotive/ military, required detail measurement of the device.
- Measurement under different **temperatures**, **smallest pulse width** is critical to reveal the actual characteristic of the device.



## Effective and Efficiency measurement

- **Compliance features** is require to make effective measurement without damaging the device.
- **Waveform inspection / Oscilloscope view** is critical to ensure smallest pulse width and yet obtain the measurement accurately.

# Next Generation of Curve Tracing



## Able to Measure Complete Static Characteristic

- New curve tracer should be able to measure **complete static characteristic** like  $I_g$ - $V_g$ ,  $V_{th}$ ,  $I_{gss}$ ... and also **Transfer characteristic** like  $V_{ge}$ - $I_c$  /  $V_{ge}$ - $V_{ce}$ .

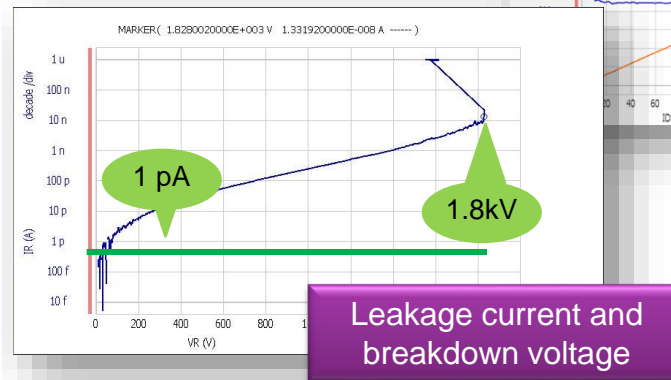
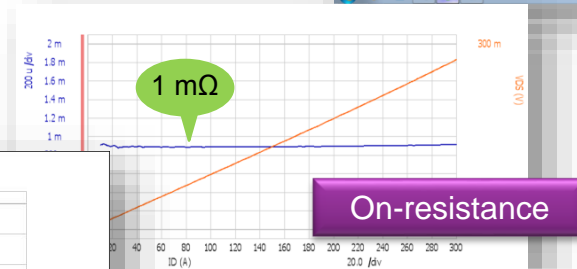
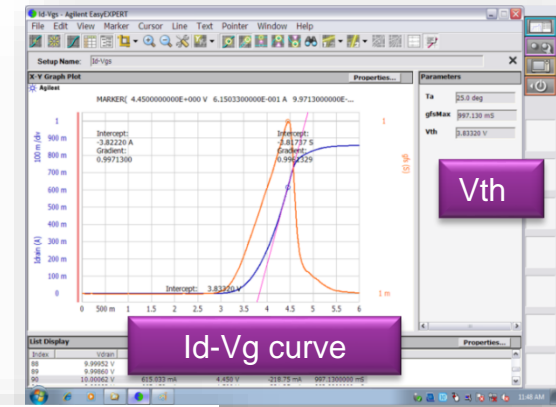
SMU Technologies to measure complete static characteristics

Tips on Power MOSFET IV Measurement

# Measure complete static characteristics

➤ Using **SMU technology**, complete static characteristics of power device can be measured easily.

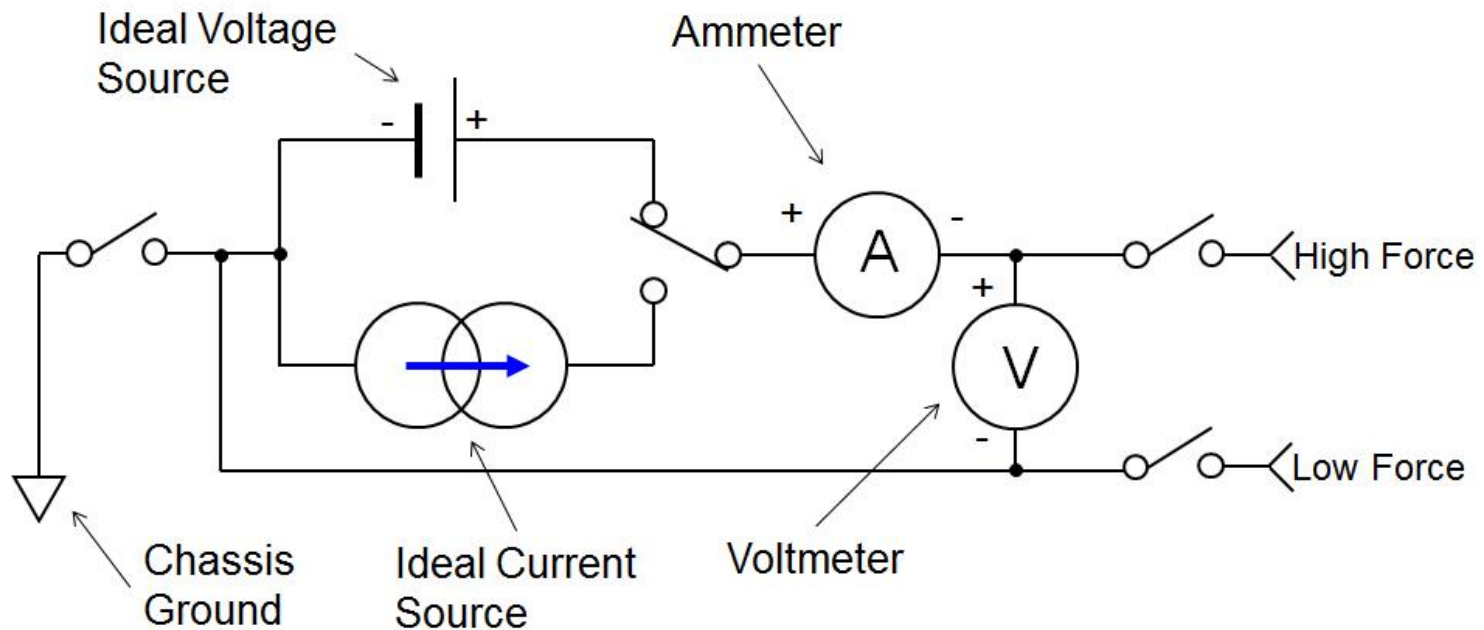
Static characteristics	Threshold voltage	$V_{(th)}$ , $V_{ge(th)}$
	Transfer Characteristics	$I_d-V_{gs}$ , $I_c-V_{ge}$ , $g_{fs}$
	On resistance	$R_{ds-on}$ , $V_{ce(sat)}$
	Gate leakage current	$I_{gss}$ , $I_{ges}$
	Output leakage current	$I_{dss}$ , $I_{ces}$
	Output Characteristics	$I_d-V_{ds}$ , $I_c-V_{ce}$
	Breakdown voltage	$BV_{ds}$ , $BV_{ces}$



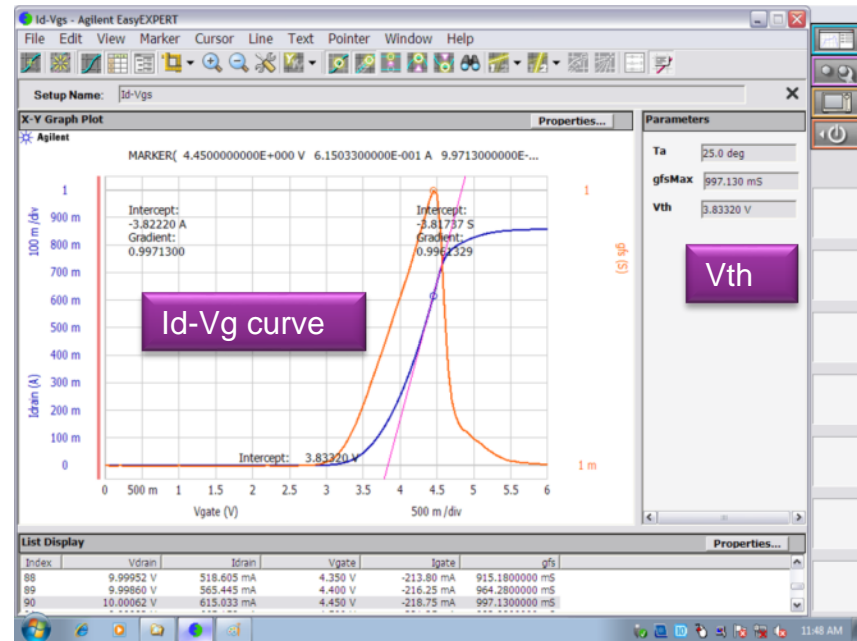
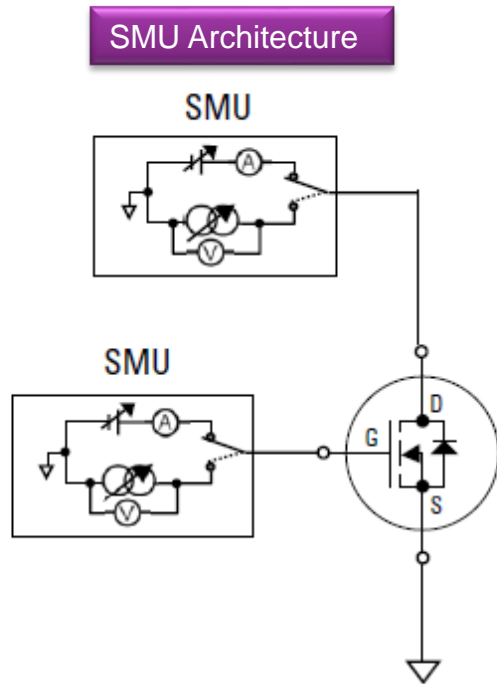
# What is a Source/Measure Unit (SMU)?

**An SMU integrates the following capabilities:**

- Four-quadrant voltage source
- Four-quadrant current source
- Voltage Meter
- Current Meter



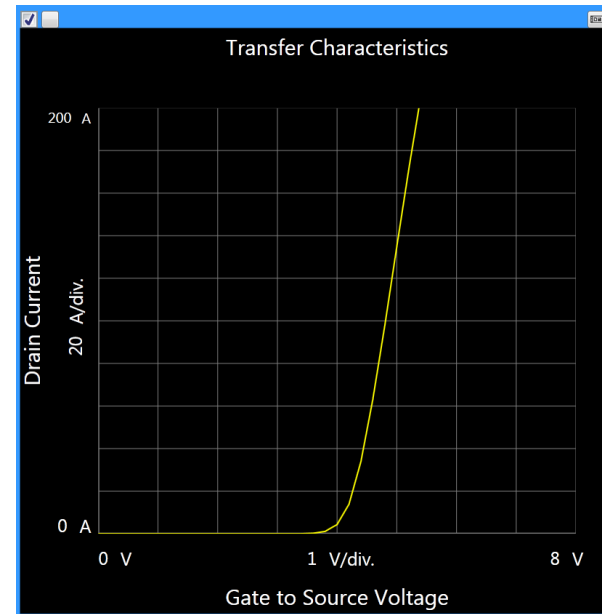
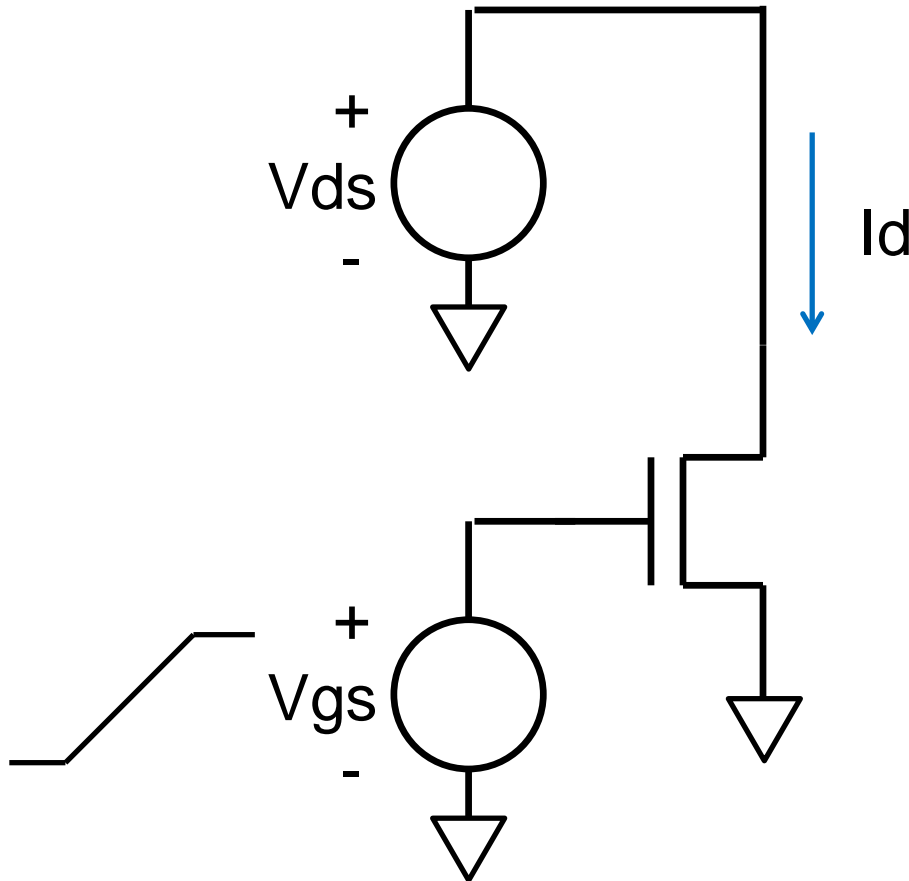
# Source/Measure Unit Technology is Much Better for Doing Id-Vg, gm and Vth Measurement



## Advantages of SMU-based Measurement:

1. Id-Vg curve is very easy to make
2. Using built-in auto analysis functions, it is easy to extract threshold voltage (Vth)

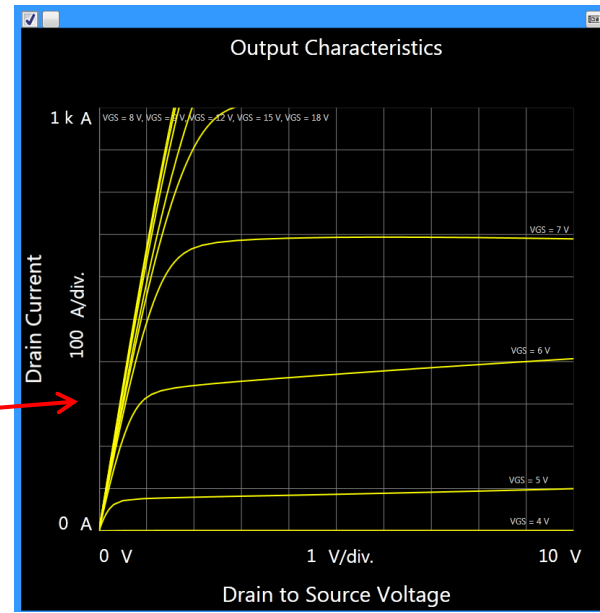
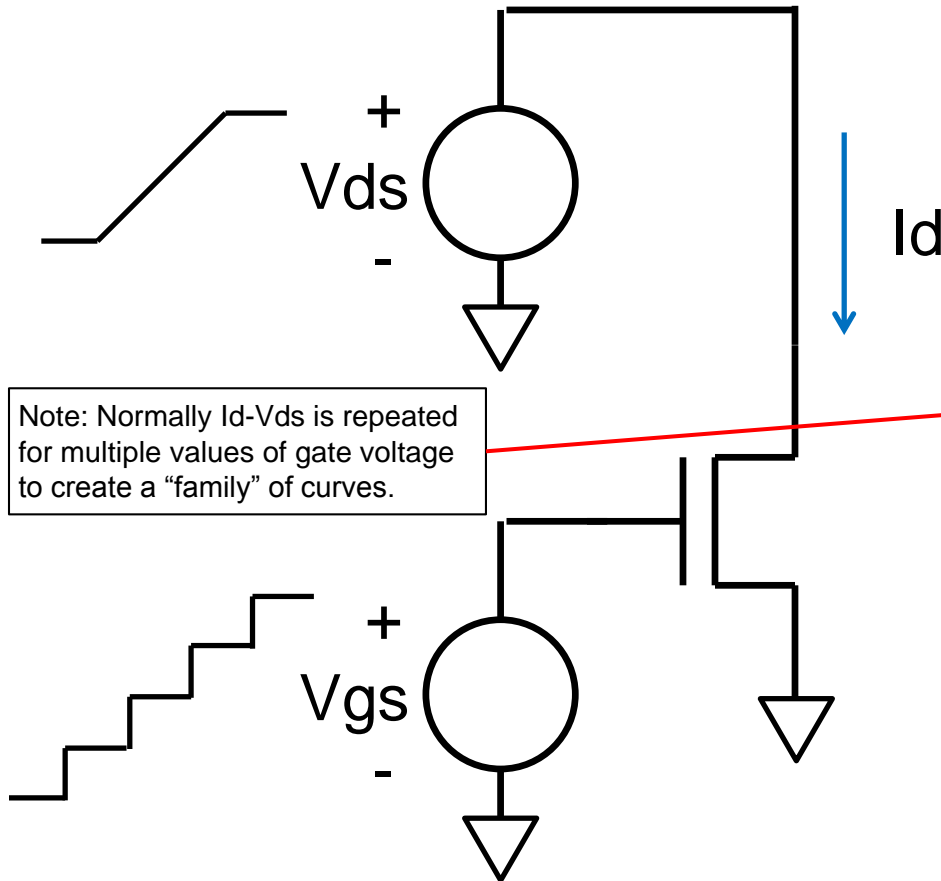
# MOSFET Transistor IV Measurement Basics – 1



$I_d$  vs.  $V_{gs}$

$I_d$  vs.  $V_{gs}$  – Sweep the voltage applied to the gate (with a fixed drain voltage) and measure the drain current as a function of gate to source voltage.

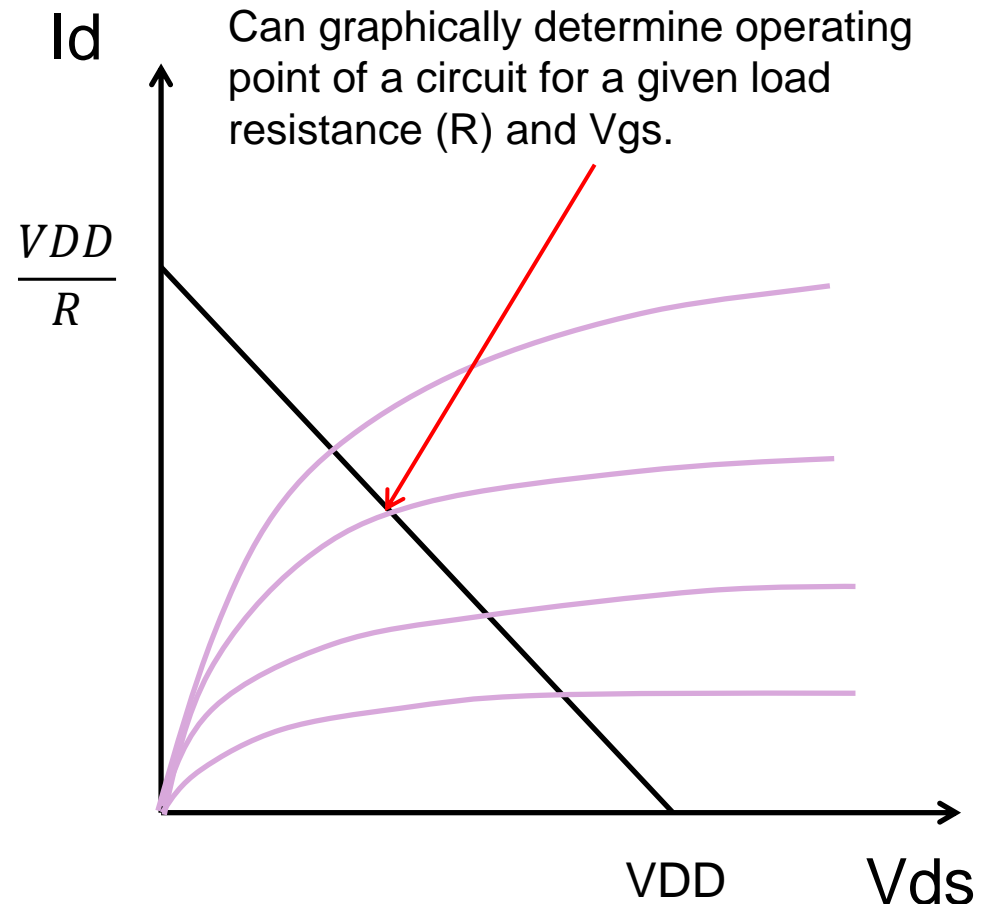
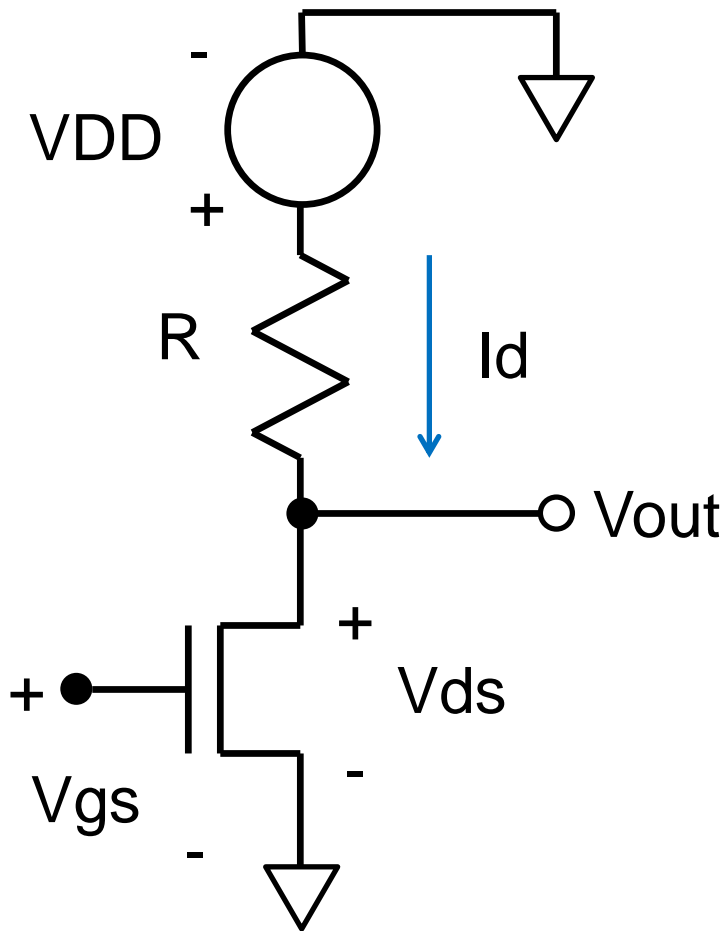
# MOSFET Transistor IV Measurement Basics – 2



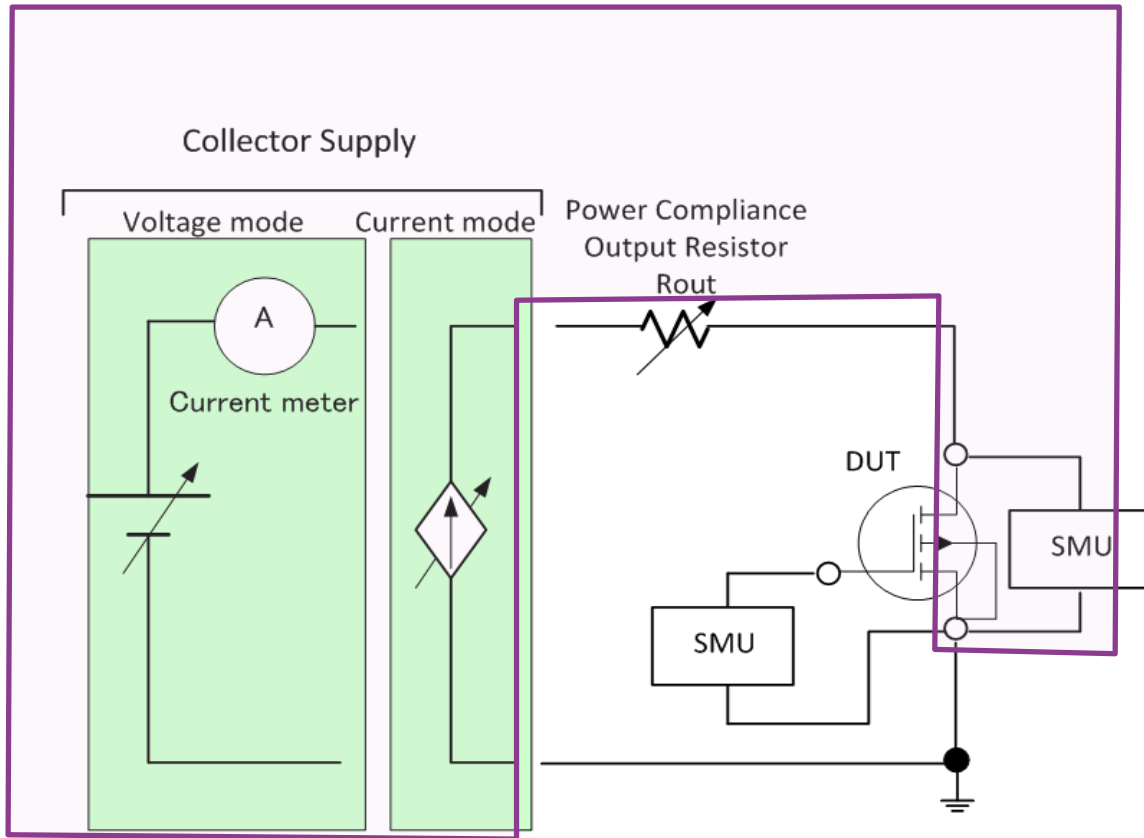
$I_d$  vs.  $V_{ds}$

$I_d$  vs.  $V_{ds}$  – Sweep the voltage applied to the drain (with a fixed gate voltage) and measure the drain current as a function of drain to source voltage.

# Why is $I_d$ - $V_{ds}$ an Important Curve?



# It is Better to Measure On Resistance by Forcing Current



Ultra-High Current Unit

## Advantages:

1. Eliminate uncertainty as to actual current flowing into drain.
2. Precision voltage measurement capability support sub-milliohm measurement resolution

# Next Generation of Curve Tracing



## Meet future power device measurement requirements

- WBG material (GaN / SiC) will improve the **switching frequency** in order to achieve higher energy efficiency.
- With higher switching frequency, **CV** and **Qg** characteristic become important parameters that need to be evaluated.

Capacitance Measurement

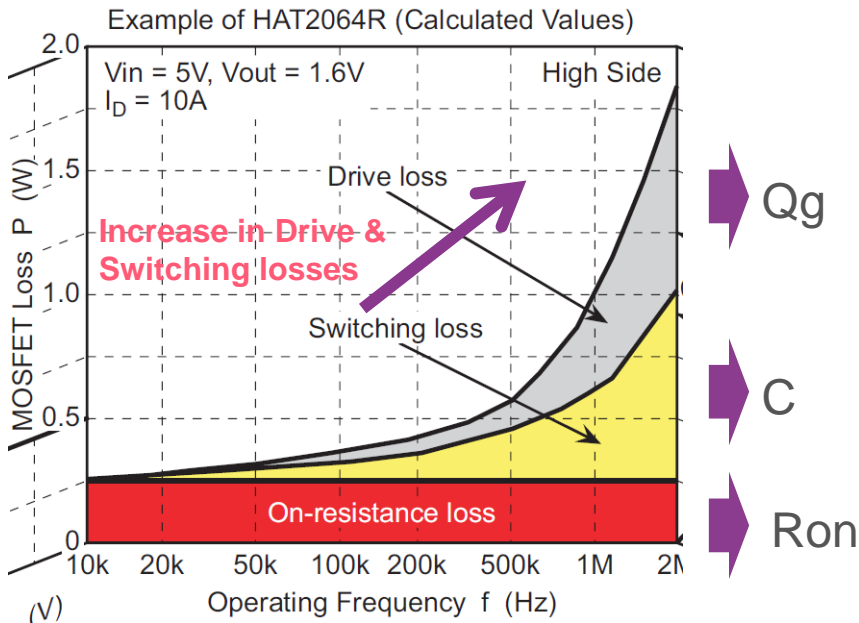
Gate Charge Measurement

GaN Current Collapse measurement

# Gate Charge and Capacitance Measurement are Needed for Higher Switching Frequency

Energy efficiency is high priority for modern power device. Switching and driving loss are increased as switching frequency goes up in order to make the equipment smaller.

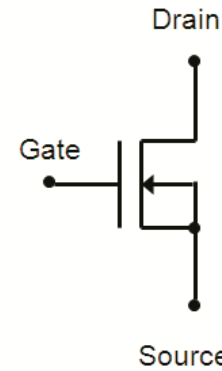
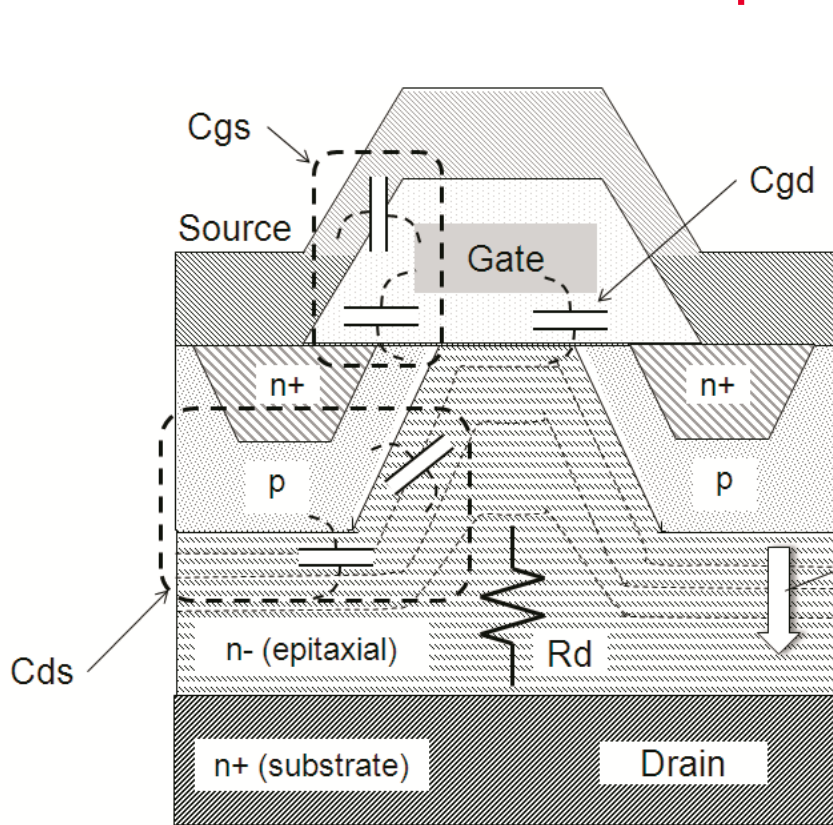
Evaluate **gate charge** and **device capacitances** are necessities.



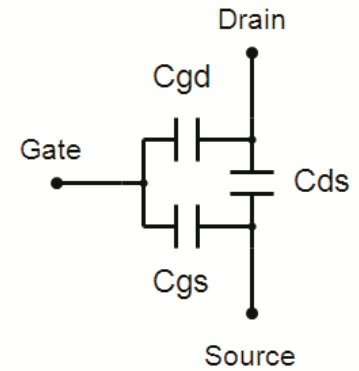
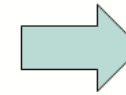
Gate charge ( $Q_g$ ) and device capacitances ( $C_{iss}$ ,  $C_{oss}$ ,  $C_{rss}$ ) evaluation is essential for power loss estimation

Higher frequency trend

# Power MOSFET Capacitance Measurement



MOSFET



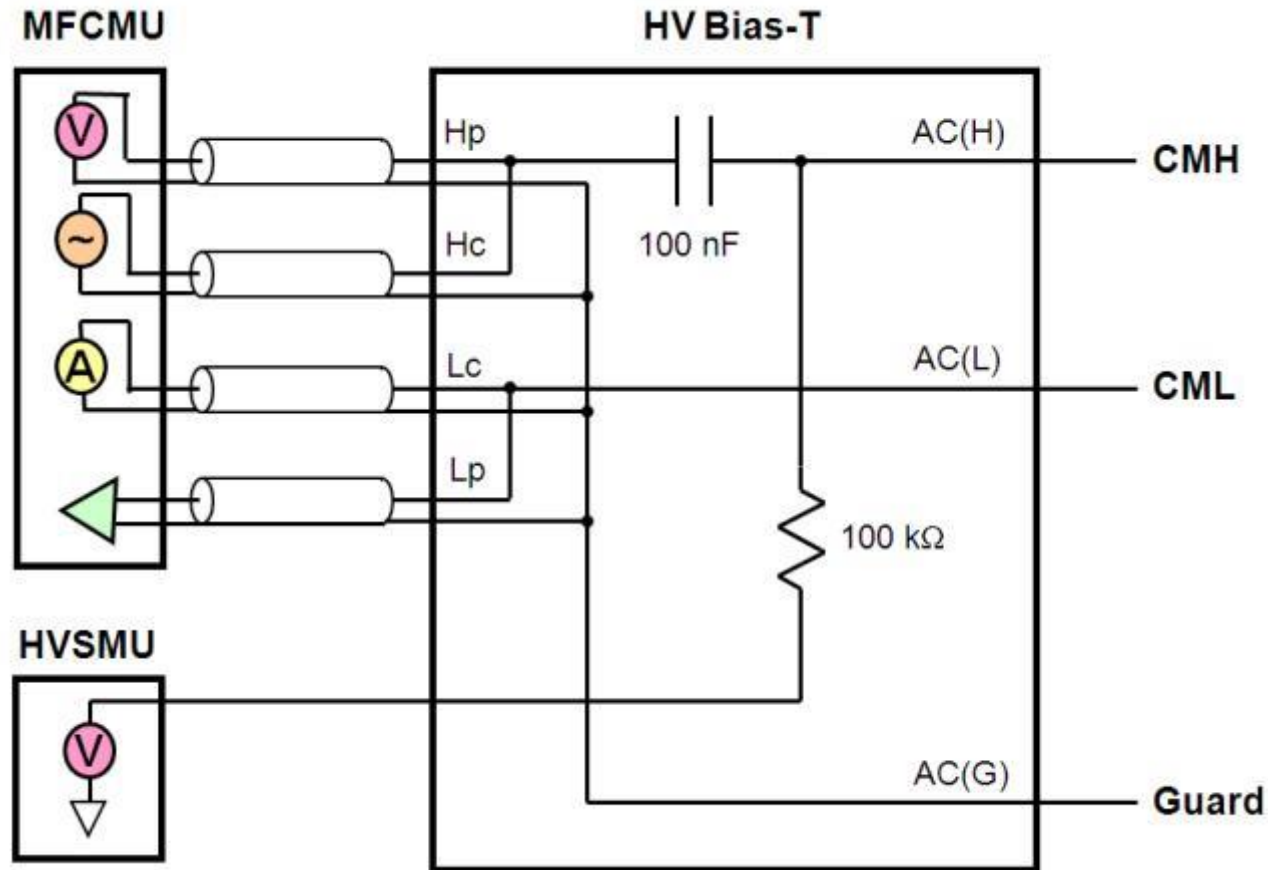
AC Equivalent Circuit

The depletion region expands with increasing drain voltage ( $V_{ds}$ )

Junction capacitances vary with applied DC voltage, so you must measure them with thousands of volts of applied DC bias.

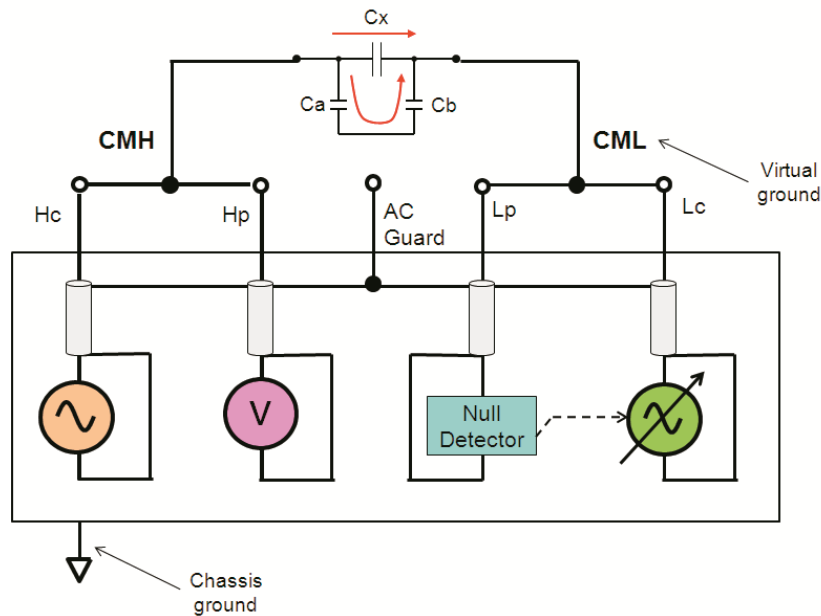
**Issue:** No off-the-shelf capacitance meter supports measurements with more than a few tens of volts of DC bias.

# High-Voltage Bias-T Measures Capacitance at 3 kV

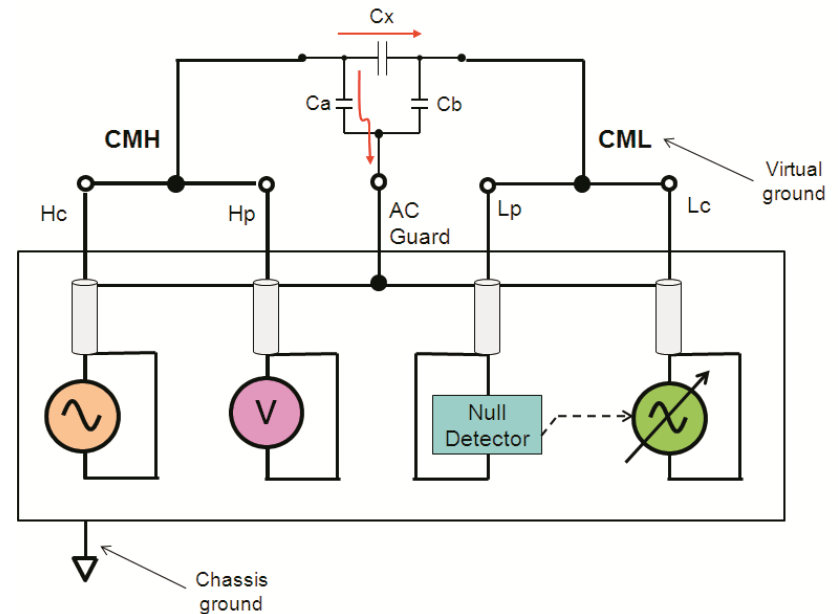


DC bias can be at thousands of volts while the AC signal is in the tens of millivolts.

# Why is There a Separate Output for the AC Guard?



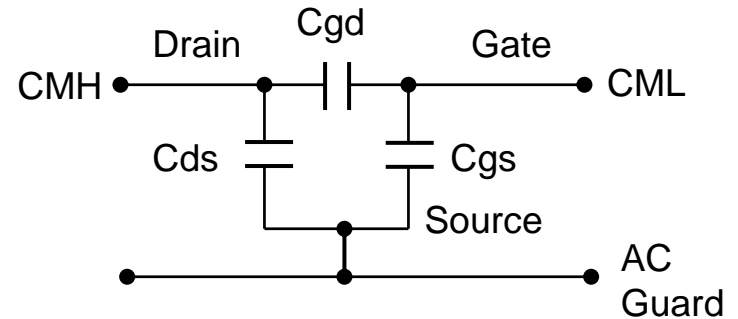
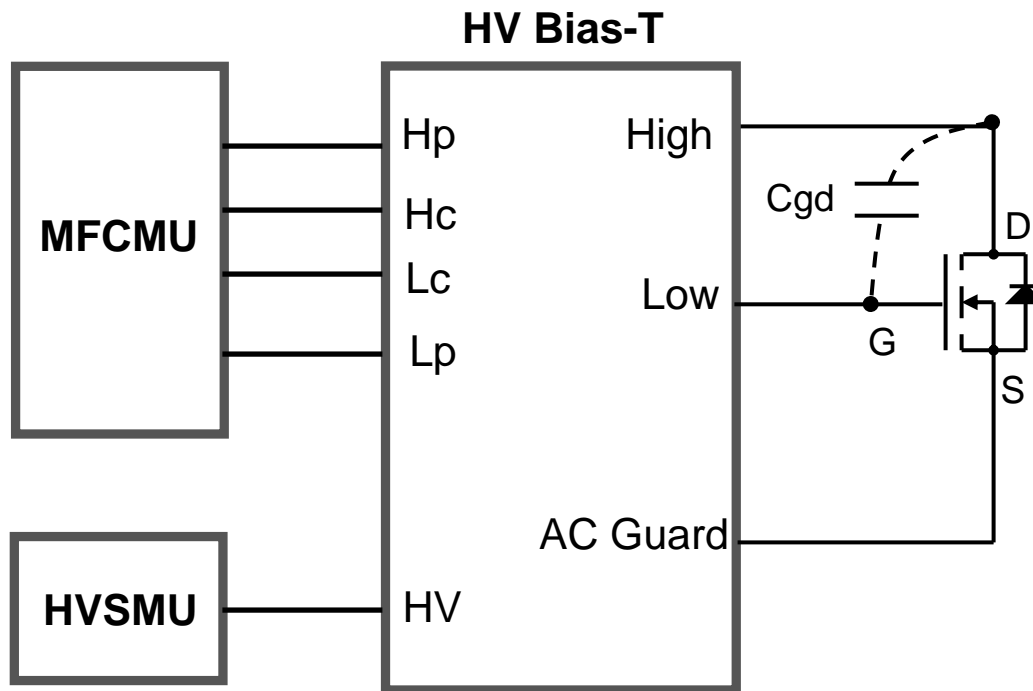
**Problem:** Some of the measured current passes through a parasitic path, which degrades measurement accuracy.



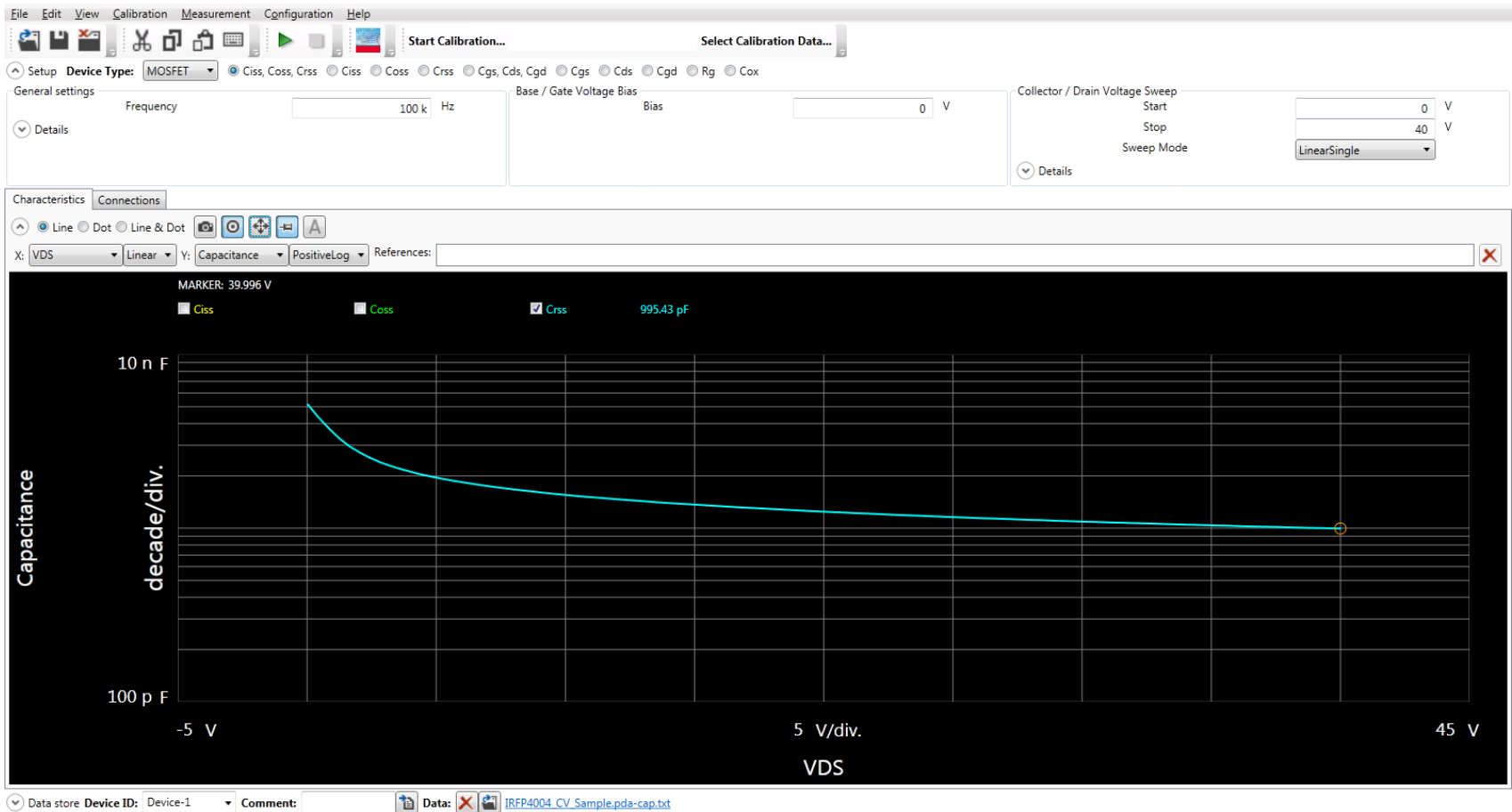
**Solution:** Use the AC guard to provide an alternative current path that keeps the parasitic current from going into the measurement node.

# Typical Crss Measurement Configuration of Normally OFF Device

$$Crss = Cgd$$

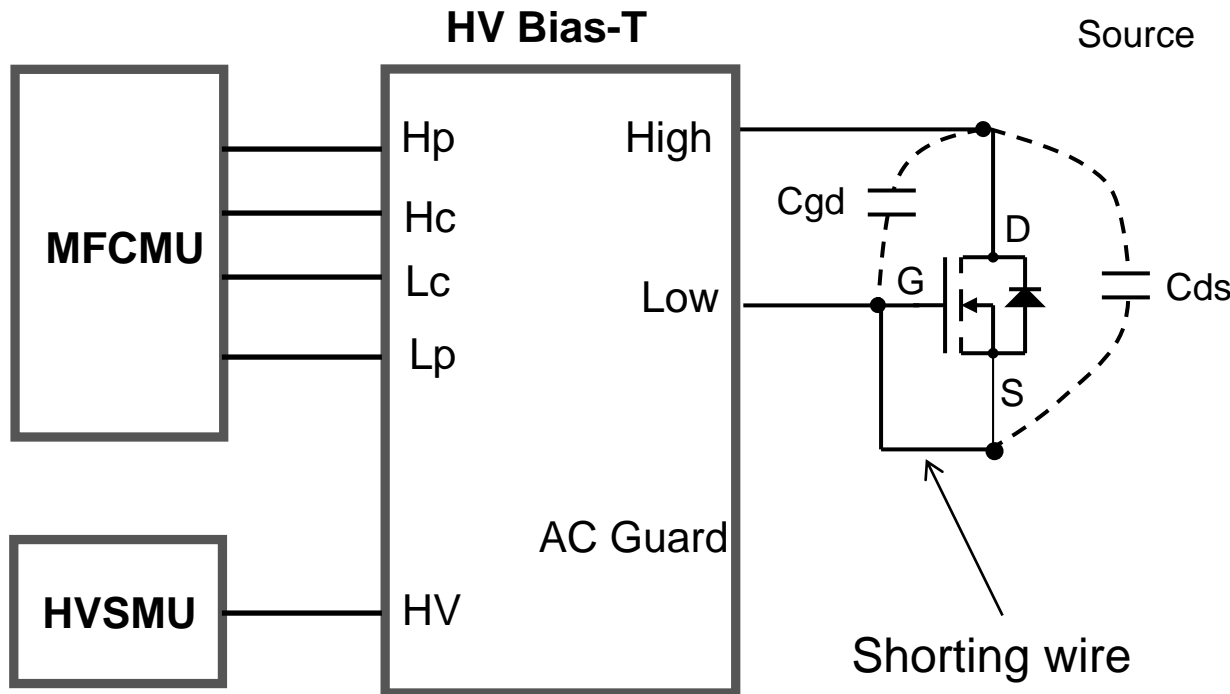
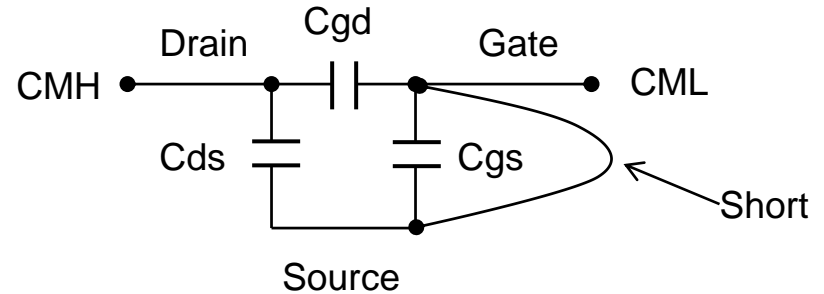


# Typical Crss Measurement Results

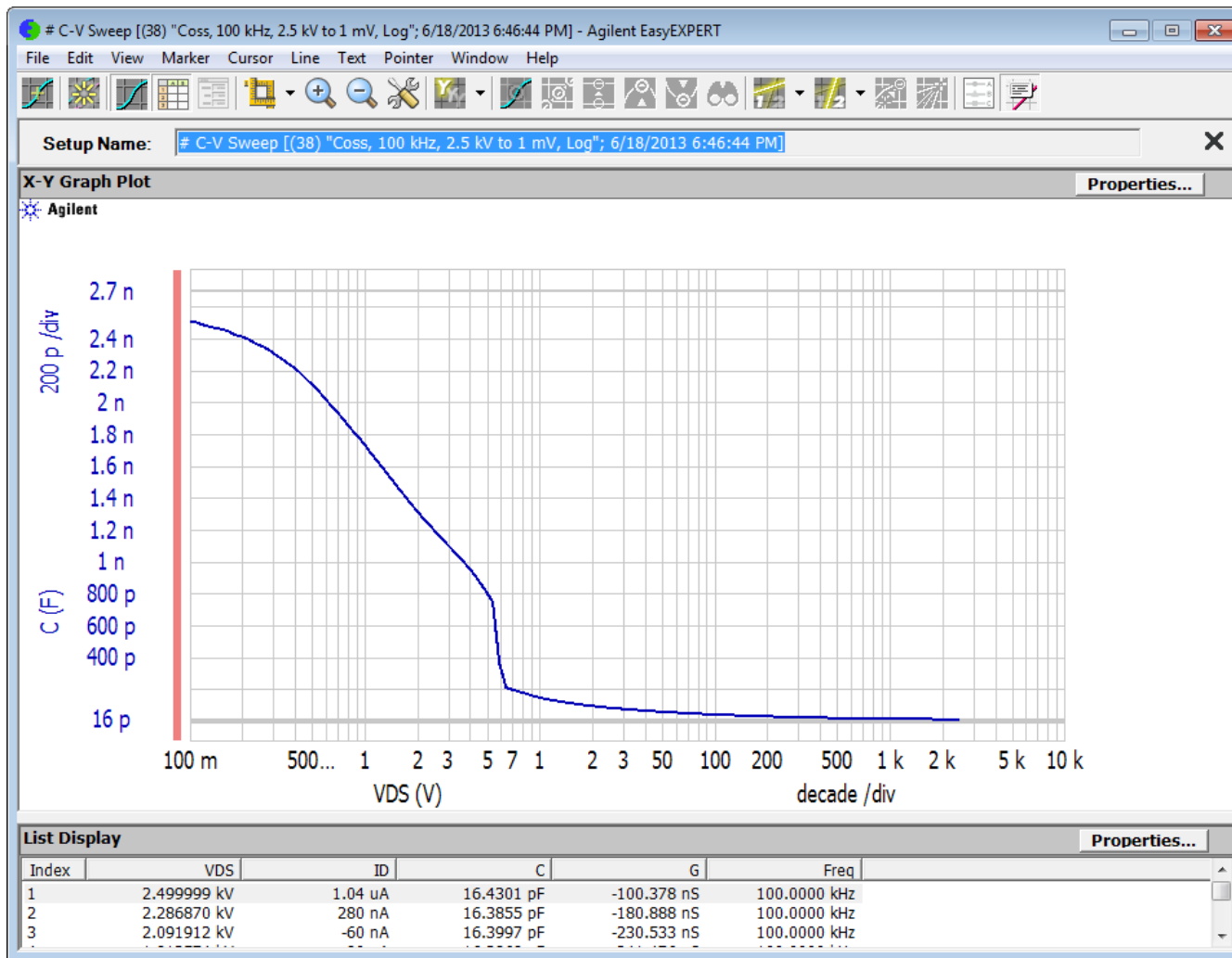


# Configuration of Coss Measurement of Normally OFF Device

$$C_{oss} = C_{gd} + C_{ds}$$

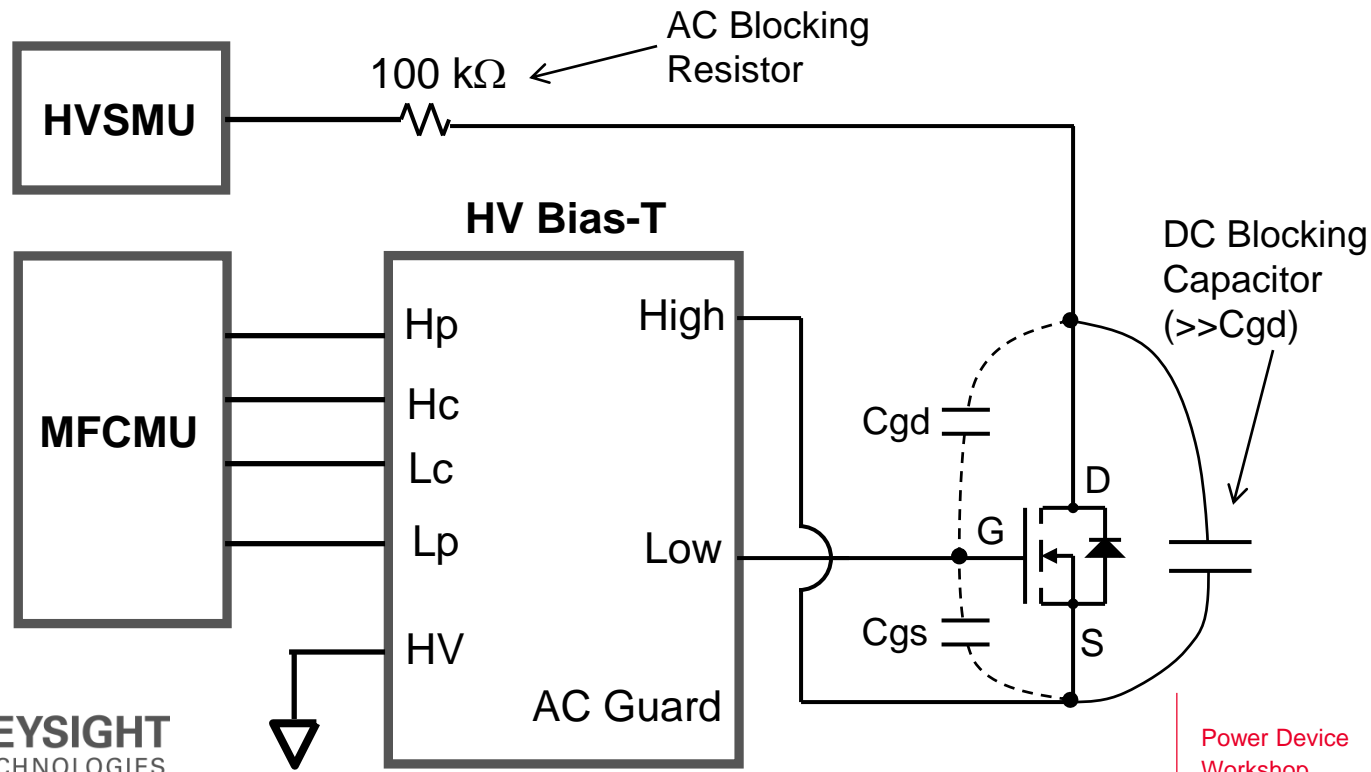
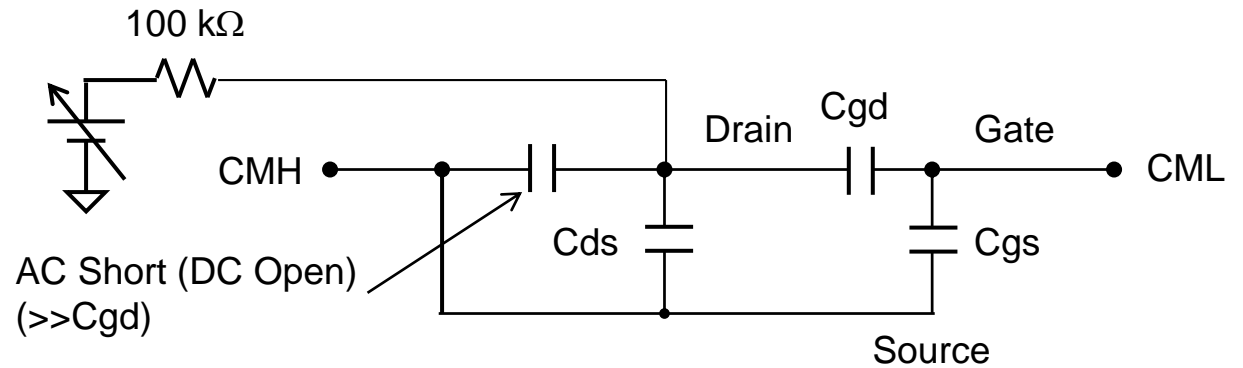


# Typical Coss Measurement Results

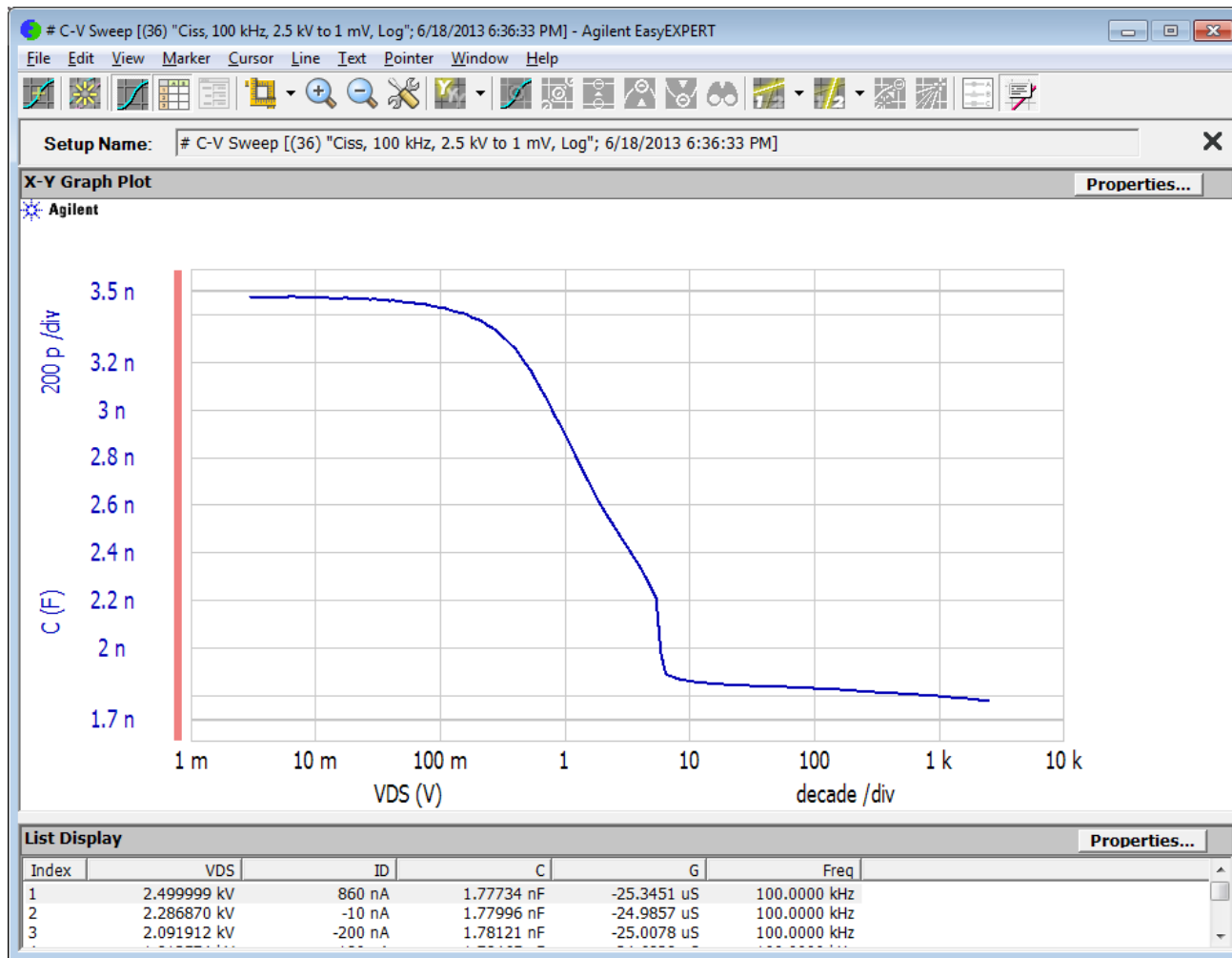


# Configuration of Ciss Measurement of Normally OFF Device

$$C_{iss} = C_{gs} + C_{gd}$$



# Typical Ciss Measurement Results

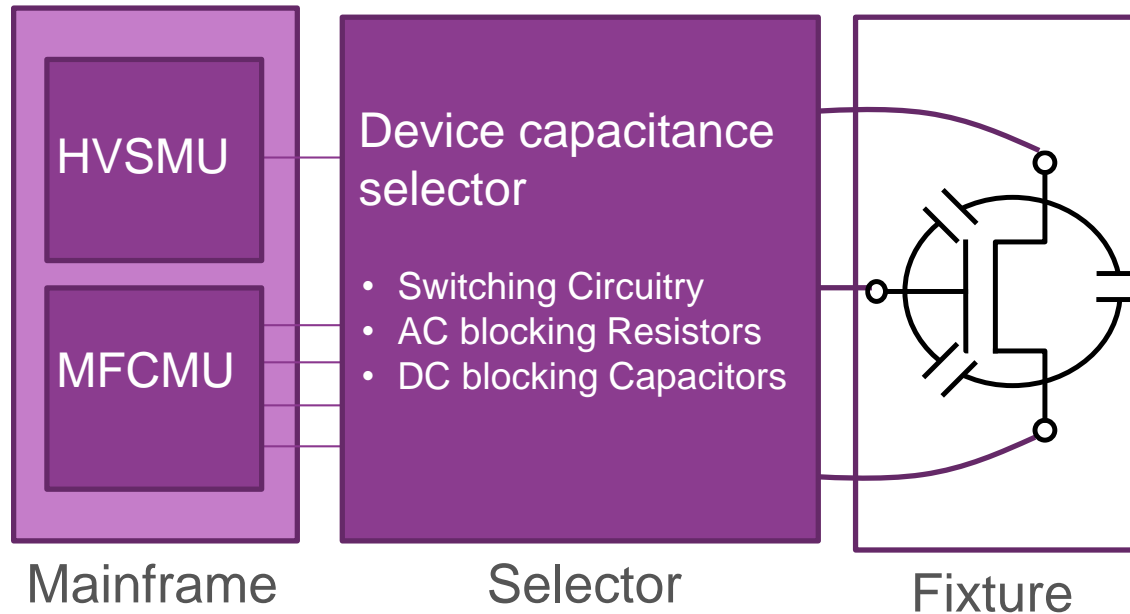


# Accurate Capacitance Measurement on Power Devices is Extremely Difficult!

- Each capacitance measurement requires some manual re-wiring of the test setup.
- The connections for each measurement can be quite complicated & require external components.
- Especially difficult to measure “normally on” devices.
- No easy way to automate Ciss, Coss and Crss measurement.
- A deep understanding of measurement theory is needed to get valid results.



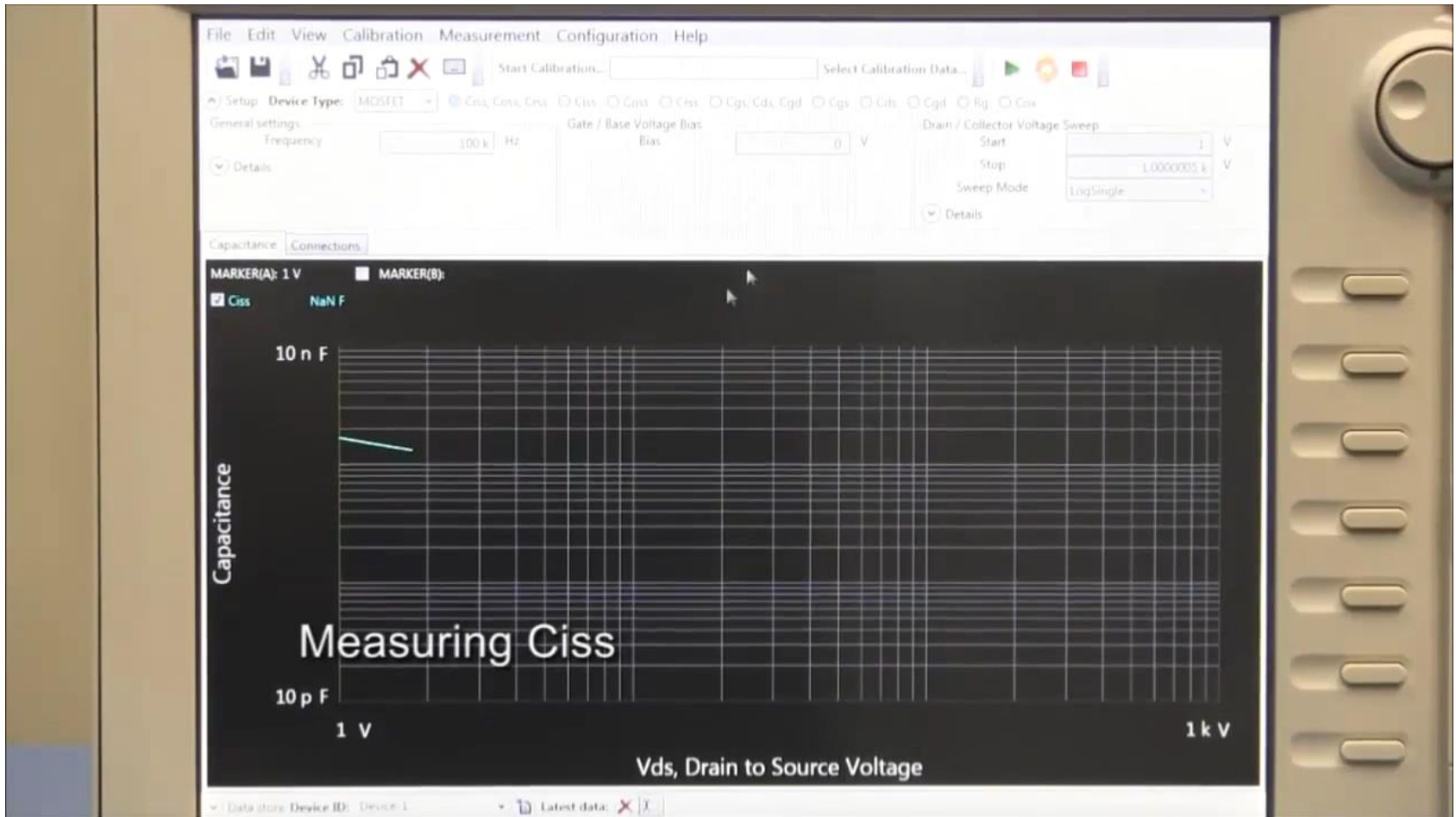
# Keysight B1506A/07A Provide an Innovative Solution that Eliminates Capacitance Measurement Complexity



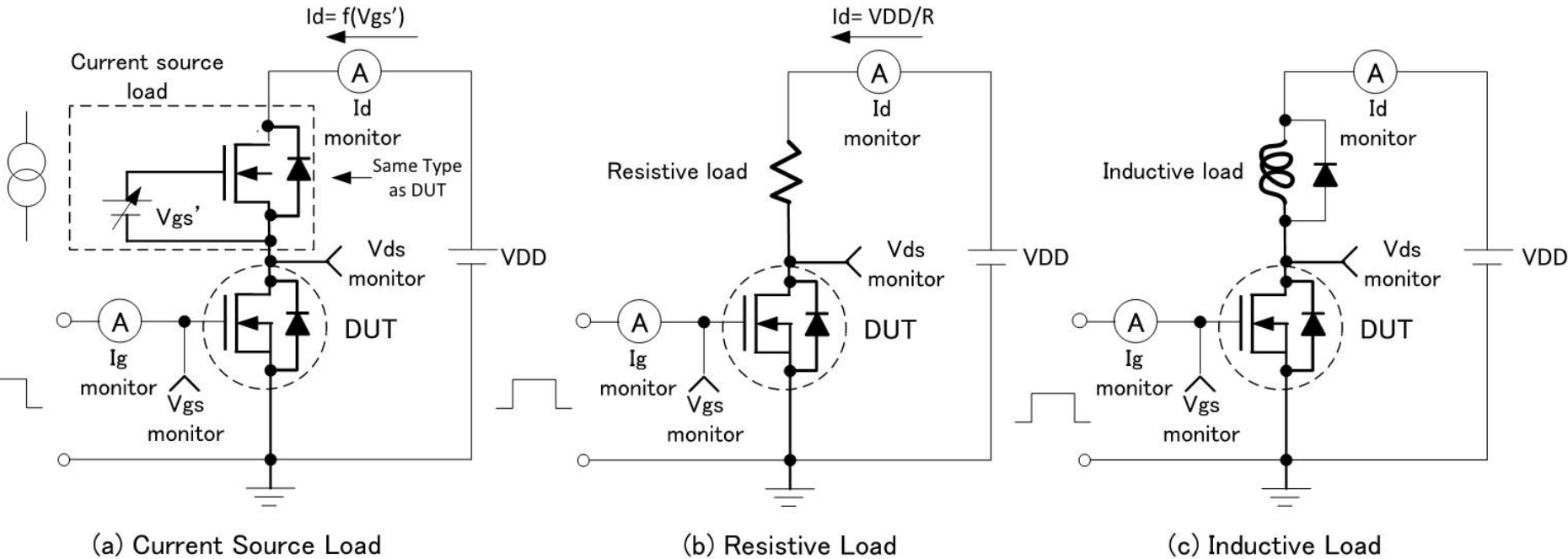
- ❖ Device capacitance selector supports more than **20 measurement configurations**
- ❖ Can measure capacitance with up to **3 kV bias** on the drain or collector
- ❖ Uses appropriate AC guarding as well as **verified compensation** techniques
- ❖ Can **characterize “normally-on” devices** such as GaN FET or SiC JFET
- ❖ Also able to perform **gate resistance** (R<sub>g</sub>) measurements

# Typical B1506A/07A Capacitance Measurements

Very complicated measurements now made easy (w/out changing cables).



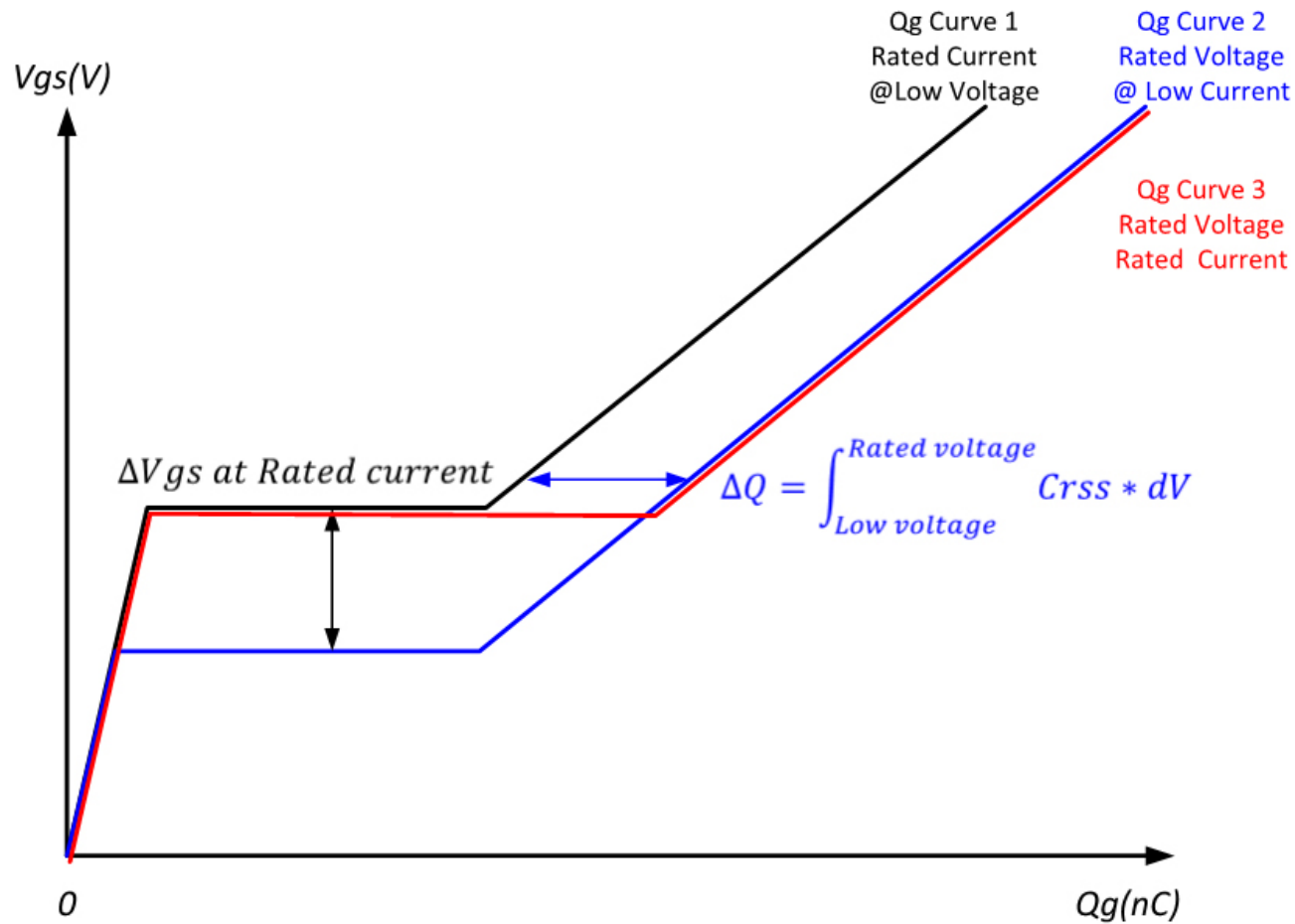
# Conventional Gate Charge (Qg) Measurement Circuits



## Key Challenges:

- Obtaining a power supply stable enough to provide accurate time-dependent output voltage and current.
- Designing a gate drive circuit that can accurately measure time-dependent current and voltage.

# Improved Qg Measurement Technique



# The Gate Charge Test Setup

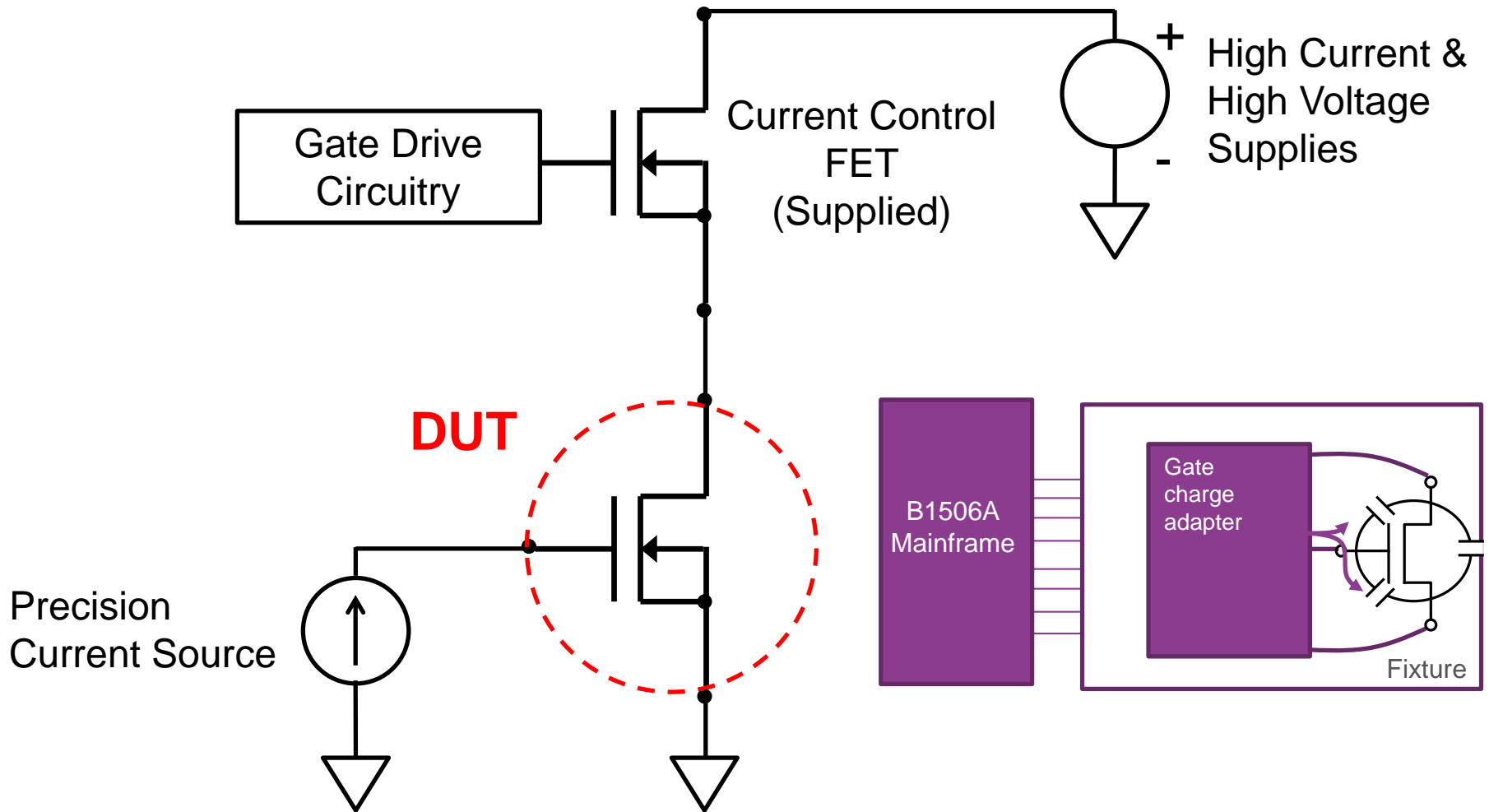


The standard 3-pin B1506A test fixture can do all measurements **except** for gate charge.

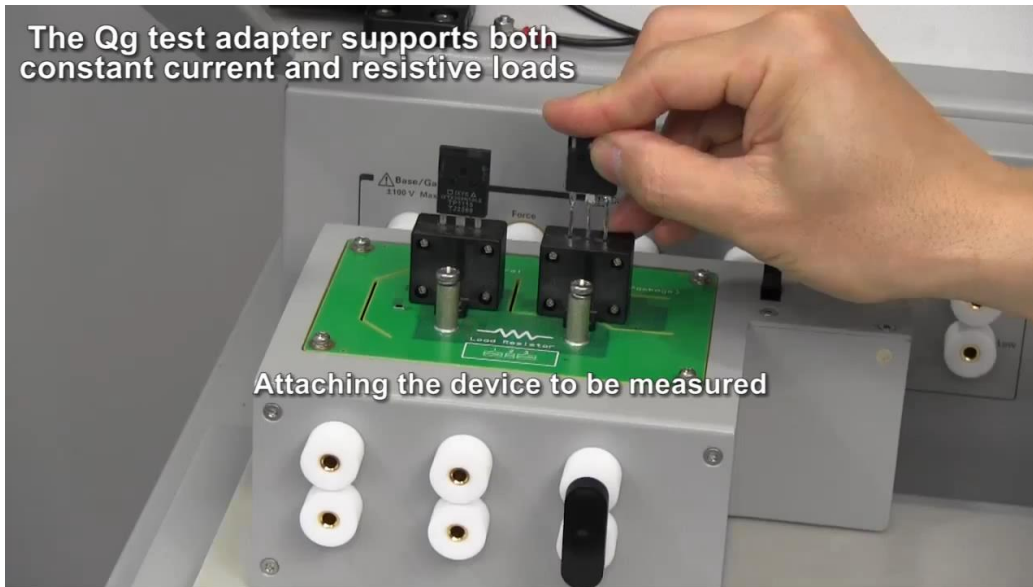


The B1506A will prompt you to insert the gate charge test fixture before starting the gate charge measurement.

# Overview of New Gate Charge Measurement Technique



# Advantages of New Gate Charge Solution



- ❖ Supports all power devices up to 3 kV, breaking the 60 V limit of commercially available  $Q_g$  test equipment
- ❖ Easily evaluate  $Q_g$  characteristics of high current and high voltage devices such as IGBT modules
- ❖  $Q_g$  characteristics along with other measured parameters can be used to automatically calculate power losses

# Next Generation of Curve Tracing



**Support automotive /  
mission critical  
requirements**

- Mission critical operation like the automotive/ military, required detail measurement of the device.
- Measurement under different **temperatures**, **smallest pulse width** is critical to reveal the actual characteristic of the device.

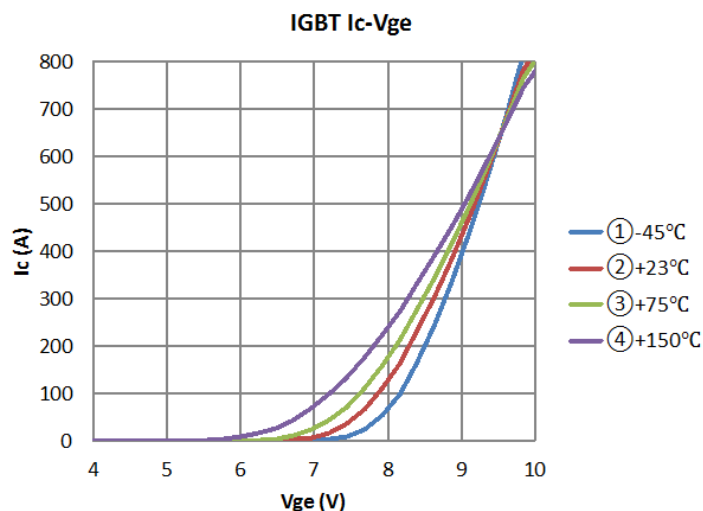
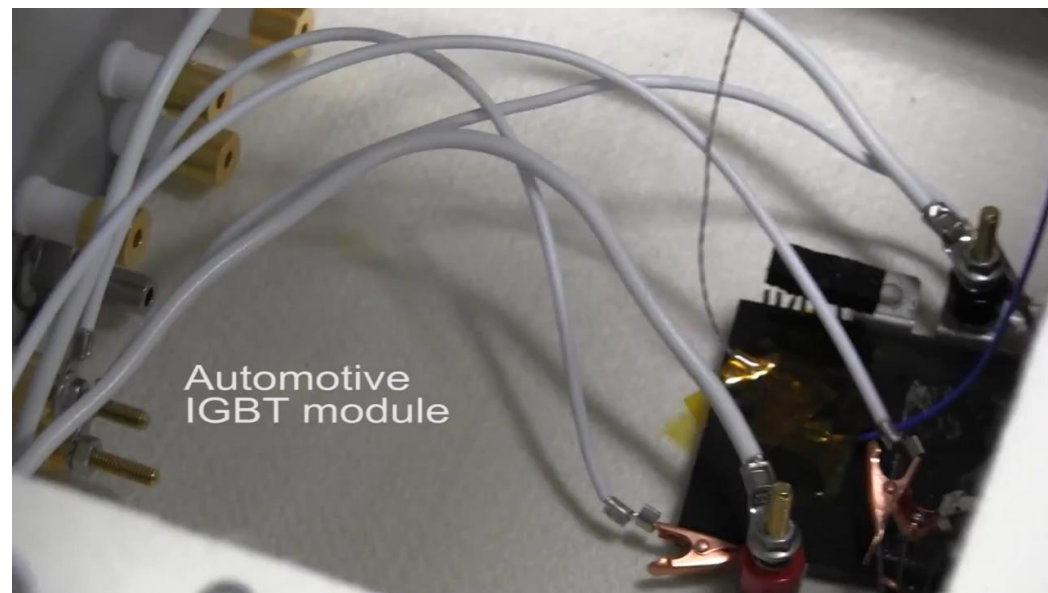
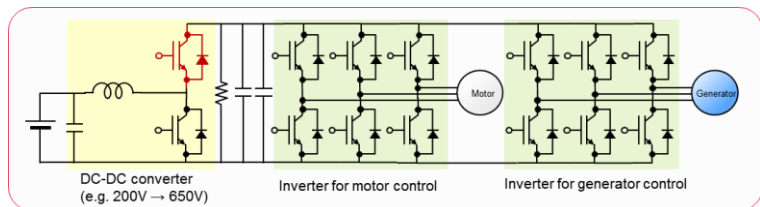
Device Characterization under  
Different Temperatures

Self Heating Issue & Pulse  
Measurement

# Safe & Fast Temperature Dependence Measurement for Automotive Market

## Power Device Characteristic Change according to Temperature

IGBT used in Power Train



*Device characteristics across temperature taken by automatic temperature dependent test with Thermostream*

Temperature dependence measurement is critical for automotive application (eg. like the IGBT used in Power Train (Power Control Unit) for EV /HEV).

# Power Device Self-Heating Issues



## For BJTs:

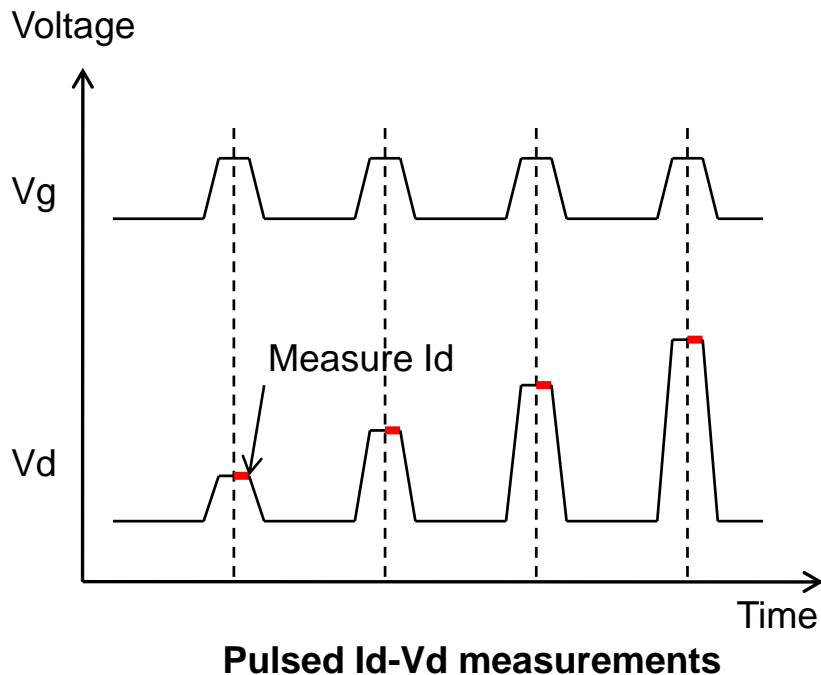
1. Collector current ( $I_c$ ) at bias  $V_{ce}$  consumes power ( $I_c \times V_{ce}$ ).
2. Power dissipation increases the C-B junction temperature, which generates more minority carriers.
3. More minority carriers in-turn increases the collector current ( $I_c$ ).
4. This increases the power dissipation, which in-turn increases the C-B junction temperature.
5. Eventually, the C-B or E-B junction reaches “**thermal destruction\***”.

## For MOSFETs:

1. Drain current ( $I_d$ ) at bias  $V_{ds}$  consumes power ( $I_d \times V_{ds}$ ).
2. As the channel temperature increases, the channel resistance also increases (negative temperature coefficient). This decreases the drain current.
3. In other words, the on-resistance  $R_{ds(on)}$  increases.
4. However, power dissipation concentrates at the pinch-off point in the channel. This can also cause “**thermal destruction\***”.

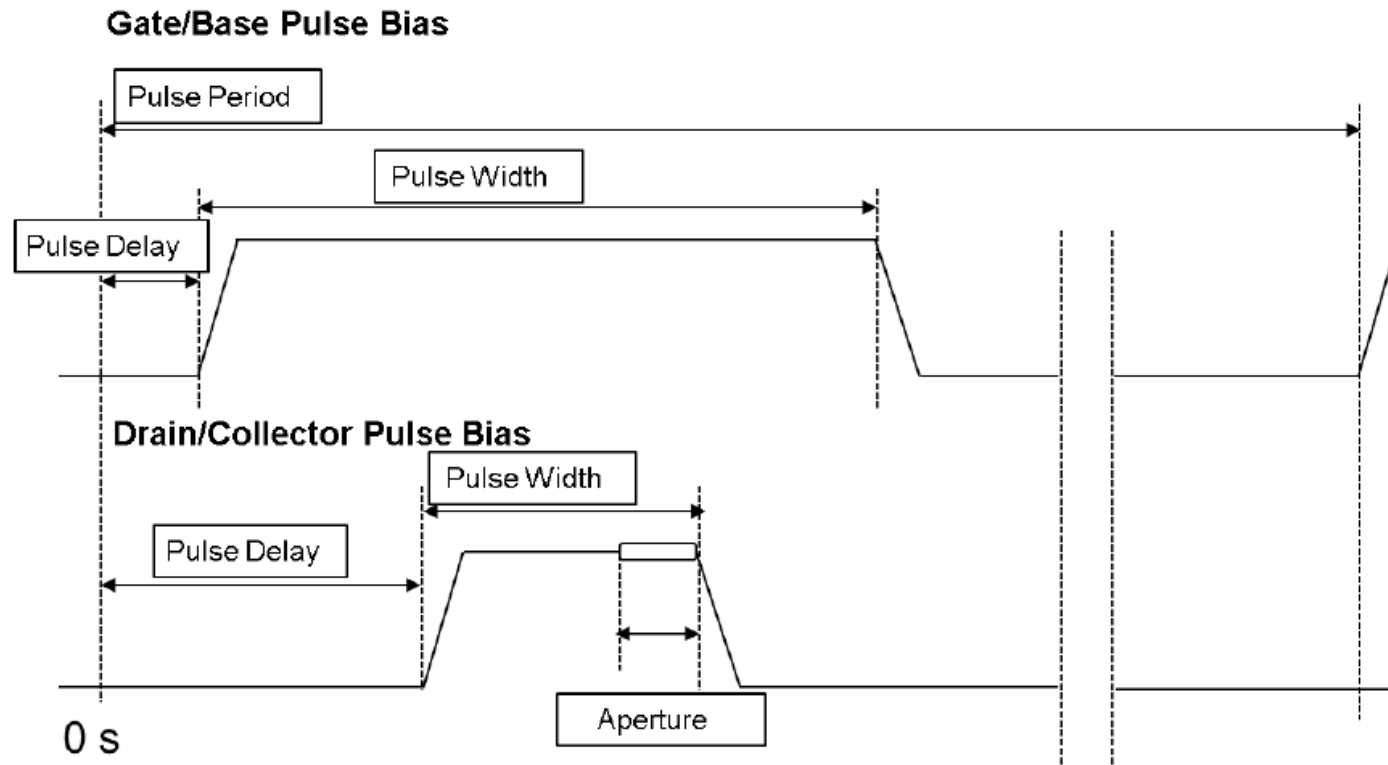
\*Aka “**thermal runaway**” 열폭주

# Making Pulsed Measurements – (1)



High power measurements on power devices must be pulsed in order to prevent device self-heating from distorting the measurement results (or damaging the device!).

# Making Pulsed Measurements – (2)



This slide shows the basic waveform timing diagram for the gate/base and drain/collector pulses.

# Making Pulsed Measurements – (3)

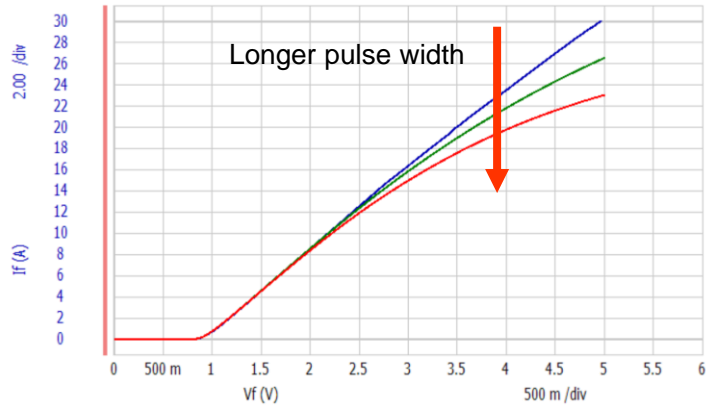
You cannot do this in offline mode, but on the B1506A you can view actual current and voltage waveforms at any selected point on a curve using the Oscilloscope view.

The screenshot displays the Keysight software interface for MOSFET measurements. The top menu includes File, Edit, View, Measurement, Configuration, and Help. The 'View' menu is active, showing options for Setup, Device Type (MOSFET), ID-VDS, ID-VGS, and VGS(th). The 'General settings' section includes 'Auto Period' and 'Pulse Period' (200 m s). The 'Details' section shows 'Gate / Base Voltage Step M' and a list of values (4, 5, 6, 7, 8, 9, 12, 15, ... V). The 'Start' and 'Stop' values are 0 V and 60 V, respectively, with a 'Voltage Compliance' of 10 V.

The main display area is divided into two panels. The left panel shows the 'Characteristics' view with a graph of Drain Current (ID) versus Drain-Source Voltage (VDS). The y-axis ranges from -200 A to 1.4 k A, and the x-axis ranges from -2 V to 14 V. Multiple curves are shown for different Gate-Source Voltages (VGS) from 4 V to 18 V. A marker is placed at 6.7542 V on the VGS = 15 V curve.

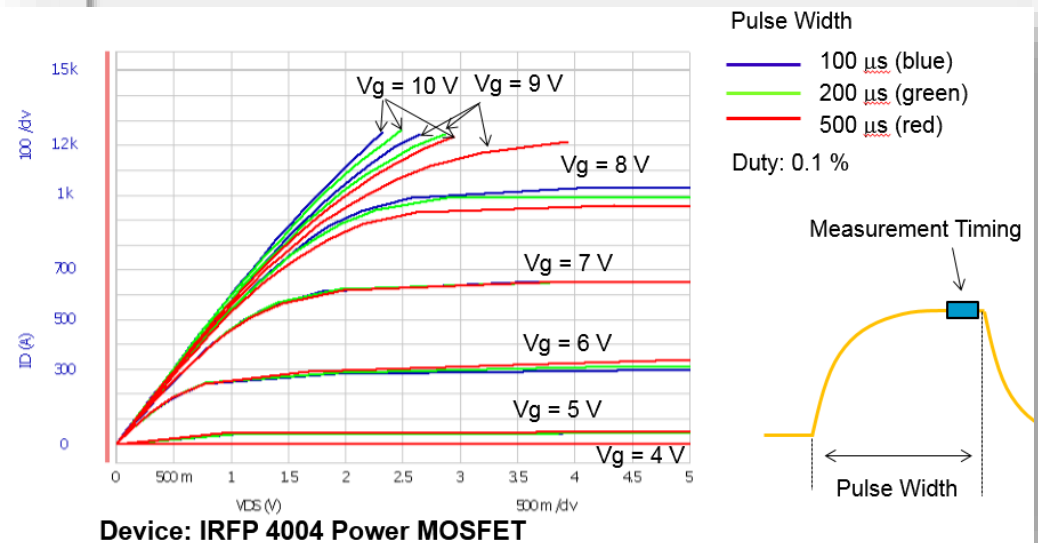
The right panel shows the 'Oscilloscope View' of the selected point. It displays waveforms for VDS (red), ID (blue), VGS (green), and IG (yellow). The y-axis ranges from -9.1862 mV to 6.9987 V, and the x-axis ranges from 0 to 250 μs. The scale is 100 μs/div. A red box highlights the 'Oscilloscope View' button in the top right corner of the right panel.

# Small Pulse Width Measurement

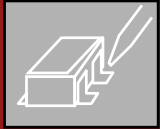


**Device self-heating** distorts data and prevents accurate device characterization when pulses are too long.

- Pulsed measurements with **<50  $\mu\text{s}$  pulse widths** required to avoid device self heating (especially for medium current at high voltage bias)



# Next Generation of Curve Tracing



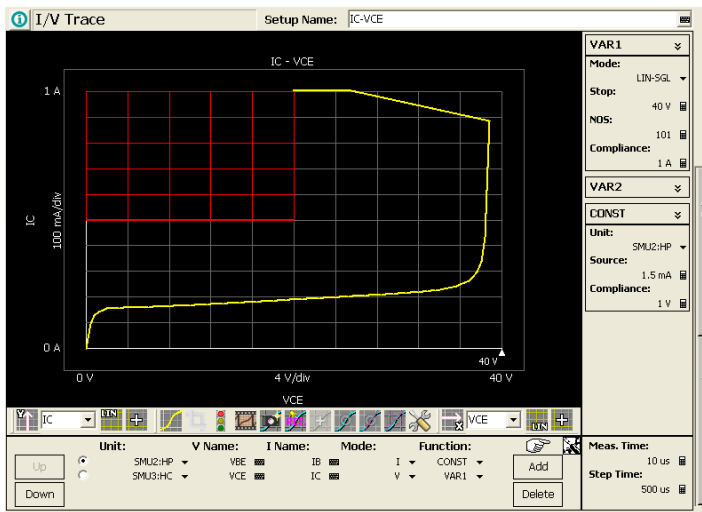
## Effective and Efficiency measurement

- **Compliance features** is require to make effective measurement without damaging the device.
- **Waveform inspection / Oscilloscope view** is critical to ensure smallest pulse width and yet obtain the measurement accurately.

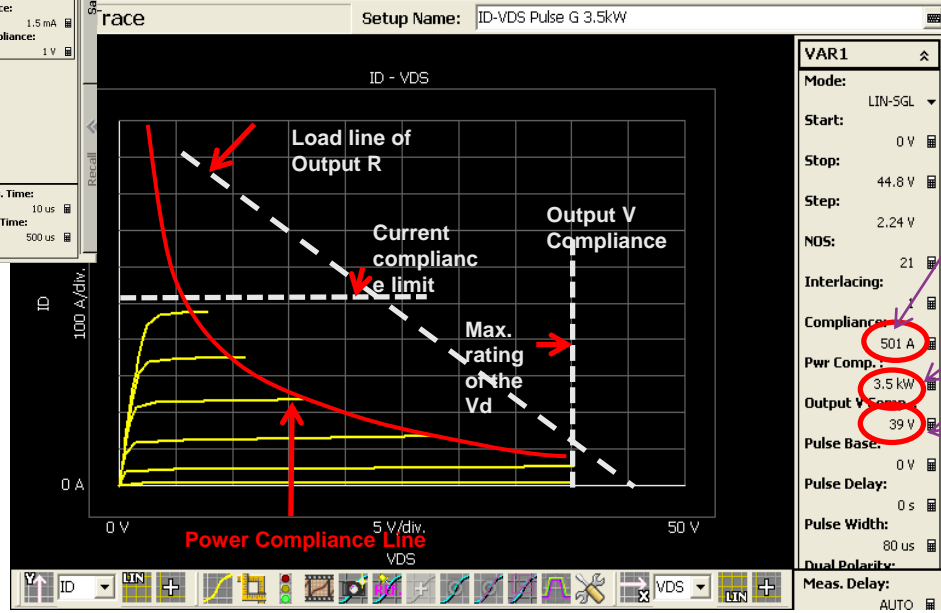
Compliance features to avoid damaging the device

Oscilloscope view to check the waveform

# Compliance features to avoid damaging the device



Zone compliance to inspect secondary breakdown



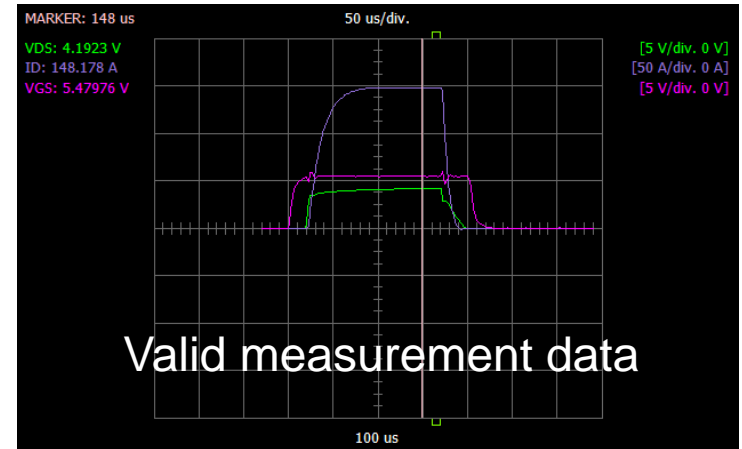
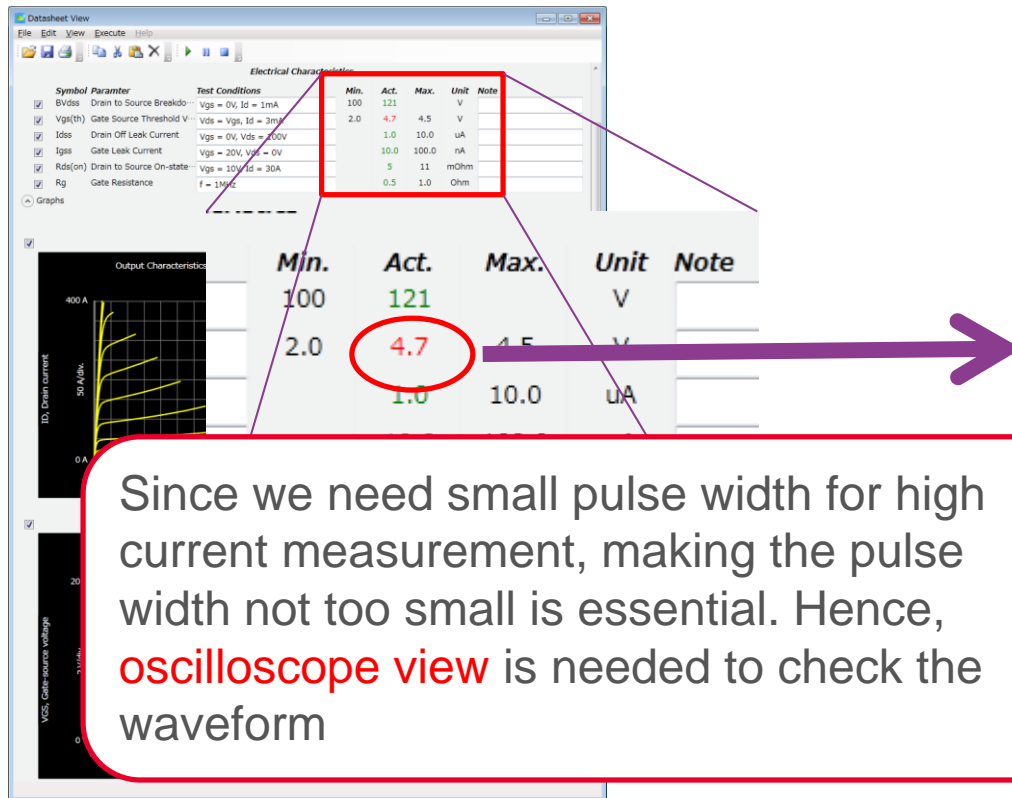
Current compliance

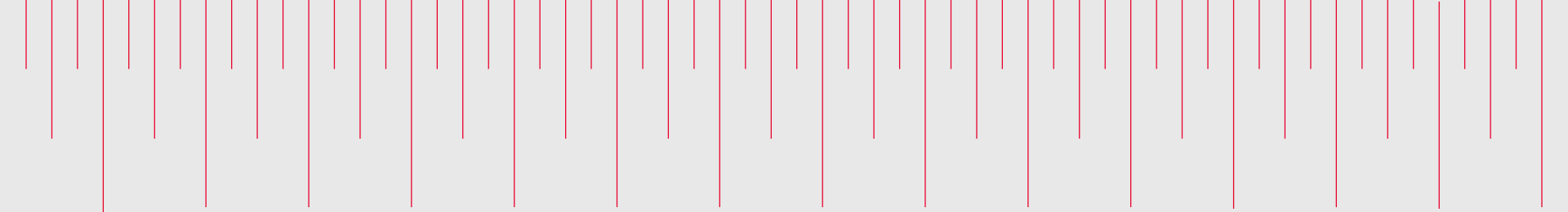
Power compliance

Voltage compliance

- ✓ Due to series resistance, equipments cannot know actual values before measurement.
- ✓ Software compliance skip rest of sweep once **measured value** over those limitations

# Oscilloscope View Allows Visual Verification of Pulsed Measurement Waveforms (Voltage & Current)





# Keysight Solutions on High Power Curve Tracing

# Total Solutions on Power Device Characterization

For R&D that need flexibility & comprehensive measurement



**B1505A**

For FA & QA that need Speed & Accurate measurement



**B1506A**

<b>Wide Coverage</b>	<u>Max Voltage</u>	10kV	3kV
	<u>Max Current</u>	1.5kA	1.5kA
<b>High Accuracy</b>	<u>Accurate Voltage (uV) / Current (fA) measurement</u>	0	0
	<u>Accurate On Resistance (uΩ) Measurement</u>	0	0
	<u>Small Pulse width (10uS)</u>	0	0
	<u>Accurate Capacitance Measurement</u>	0	0
	<u>Accurate Qg Measurement</u>	0	0
<b>Additional Features for WBG material</b>	<u>Thermal Solutions (Thermal Plat / Thermostream)</u>	0	0
	<u>GaN Current Collapse Measurement</u>	0	
	<u>5 / 6 Terminal Measurement (Intelligent IGBT)</u>	0	
<b>High Effective &amp; Efficient Measurement</b>	<u>Current/Voltage/Power Compliance</u>	0	0
	<u>Oscilloscope view</u>	0	0
	<u>Support Wafer Level Testing</u>	0	
	<u>Build in Window base Test Application software</u>	0	0
	<u>Datasheet mode &amp; one click measurement</u>		0

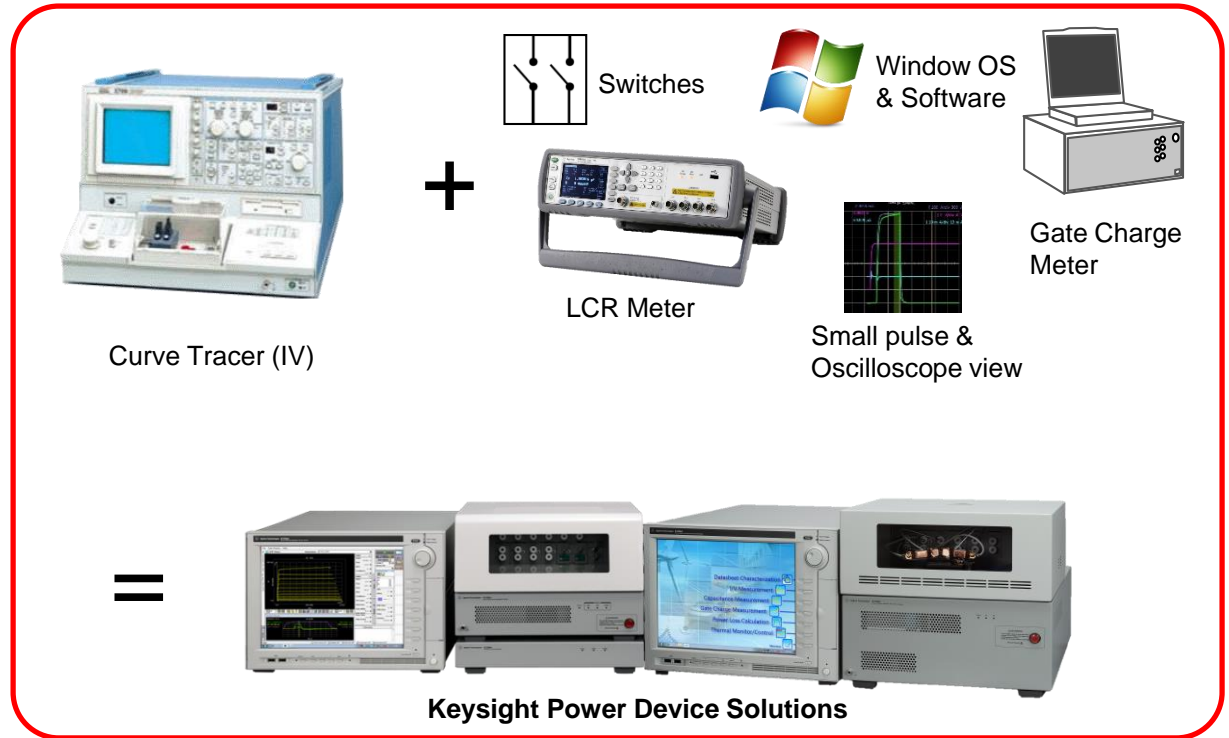
# The B1505A / B1506A is more than just a Digital Curve Tracer

✓ Measure complete static characteristic

✓ Meet future power device measurement requirements

✓ Support automotive / mission critical requirements

✓ Effective and Efficiency measurement



Keysight Power Device Solutions meet your **current and future needs**

# Question & Answer Session



Thank you for your kind attention

